



# **bq2419x I<sup>2</sup>C Controlled 4.5-A Single Cell USB/Adapter Charger with Narrow VDC Power Path Management and USB OTG**

## 1 Features

- High Efficiency 4.5-A Switch Mode Charger
  - 92% Charge Efficiency at 2 A, 90% at 4 A
  - Accelerate Charge Time by Battery Path Impedance Compensation
- Compatible with MaxLife Technology for Faster Charging When Used in Conjunction With bq27531
- Highest Battery Discharge Efficiency with 12-mΩ Battery Discharge MOSFET up to 9-A Discharge Current
- Single Input USB-compliant/Adapter Charger
  - USB Host or Charging Port D+/D- Detection Compatible to USB Battery Charger Spec 1.2
  - Input Voltage and Current Limit Supports USB2.0 and USB3.0
  - Input Current Limit: 100 mA, 150 mA, 500 mA, 900 mA, 1.2 A, 1.5 A, 2 A and 3 A
- 3.9-V to 17-V Input Operating Voltage Range
  - Support All Kinds of Adapter with Input Voltage DPM Regulation
- USB OTG 5 V at 1.3-A Synchronous Boost Converter Operation
  - 93% 5-V Boost Efficiency at 1 A
- Narrow VDC (NVDC) Power Path Management
  - Instant-on Works with No Battery or Deeply Discharged Battery
  - Ideal Diode Operation in Battery Supplement Mode
- 1.5-MHz Switching Frequency for Low Profile Inductor
- Autonomous Battery Charging with or without Host Management
  - Battery Charge Enable
  - Battery Charge Preconditioning
  - Charge Termination and Recharge
- High Accuracy (0°C to 125°C)
  - ±0.5% Charge Voltage Regulation
  - ±7% Charge Current Regulation
  - ±7.5% Input Current Regulation
  - ±2% Output Regulation in Boost Mode
- High Integration
  - Power Path Management
  - Synchronous Switching MOSFETs

- Integrated Current Sensing
- Bootstrap Diode
- Internal Loop Compensation
- Safety
  - Battery Temperature Sensing and Charging Safety Timer
  - Thermal Regulation and Thermal Shutdown
  - Input System Over-Voltage Protection
  - MOSFET Over-Current Protection
- Charge Status Outputs for LED or Host Processor
- Low Battery Leakage Current and Support Shipping Mode
- 4.00 mm x 4.00 mm VQFN-24 Package

## 2 Applications

- Tablet PC and Smart Phone
- Portable Audio Speaker
- Portable Media Players
- Internet Devices

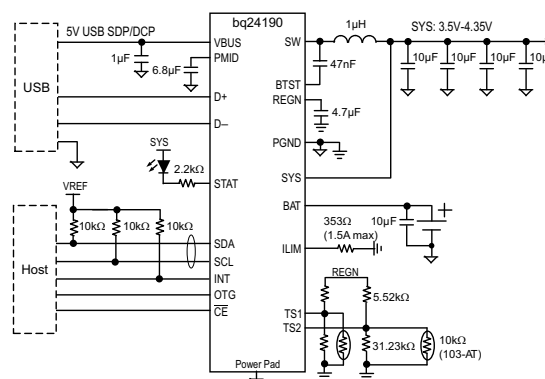
## 3 Description

The bq24190, bq24192, and bq24192I are highly-integrated switch-mode battery charge management and system power path management devices for single cell Li-Ion and Li-polymer battery in a wide range of tablet and other portable devices.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |
|-------------|-----------|-------------------|
| bq24190     | VQFN (24) | 4.00 mm x 4.00 mm |
| bq24192     |           |                   |
| bq24192I    |           |                   |

(1) For all available packages, see the orderable addendum at the end of the datasheet.



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## 4 Revision History

| Changes from Revision A (October 2012) to Revision B                                                                                                                                                                        | Page      |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------|
| Aligned package description throughout datasheet .....                                                                                                                                                                      | <b>1</b>  |
| Added ESD Ratings, Feature Description, Device Functional Modes, Application and Implementation, Power Supply Recommendations, Layout, Device and Documentation Support, Mechanical, Packaging, Orderable Information. .... | <b>1</b>  |
| Added Feature: Compatible with MaxLife Technology for Faster Charging When Used in Conjunction With bq27531 .....                                                                                                           | <b>1</b>  |
| Changed $V_{SLEEPZ}$ , $V_{BAT\_DPL\_HY}$ , $V_{BATGD}$ , $I_{CHG\_20pct}$ , $V_{SHORT}$ , $I_{ADPT\_DPM}$ , $K_{ILIM}$ , $V_{BTST\_REFRESH}$ in Electrical Characteristics .....                                           | <b>6</b>  |
| Added $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$ to $I_{BAT}$ Test Condition .....                                                                                                                                       | <b>6</b>  |
| Added $REG00[6:3] = 0110$ (4.36 V) or $1011$ (4.76 V) to $V_{INDPM\_REG\_ACC}$ Test Conditions .....                                                                                                                        | <b>8</b>  |
| Added Typical input current of 1.5 A based on $K_{ILIM}$ to $I_{ADPT\_DPM}$ Test Conditions .....                                                                                                                           | <b>8</b>  |
| Added a MIN value of 435 to $K_{ILIM}$ .....                                                                                                                                                                                | <b>8</b>  |
| Deleted $T_{Junction\_REG}$ MIN and MAX .....                                                                                                                                                                               | <b>8</b>  |
| Added rising to $V_{HTF}$ parameter .....                                                                                                                                                                                   | <b>8</b>  |
| Deleted $V_{REGN}$ , $V_{VBUS} = 5\text{ V}$ , $I_{REGN} = 20\text{ mA}$ MAX value .....                                                                                                                                    | <b>9</b>  |
| Changed Functional Block Diagram .....                                                                                                                                                                                      | <b>12</b> |
| Changed Charging Current in <a href="#">Table 4</a> .....                                                                                                                                                                   | <b>18</b> |
| Changed $REG09[5:4]$ to $REG08[5:4]$ in Charging Termination section .....                                                                                                                                                  | <b>21</b> |
| Added or when $FORCE\_20PCT$ ( $REG02[0]$ ) bit is set, to Charging Safety Timer description .....                                                                                                                          | <b>22</b> |
| Added last paragraph to Charging Safety Timer description .....                                                                                                                                                             | <b>22</b> |
| Added twice to Host Mode and Default Mode description .....                                                                                                                                                                 | <b>27</b> |
| Changed $REG05[5:4]=11$ to $REG05[5:4]=00$ in Host Mode and Default Mode description .....                                                                                                                                  | <b>27</b> |
| Changed Charge Current Control Register $REG02$ Bit 0 description .....                                                                                                                                                     | <b>31</b> |
| Changed Charge Current Control Register $REG02$ Bit 0 note .....                                                                                                                                                            | <b>31</b> |
| Changed $REG05$ Bit 0 from JEITA ISET ( $0^{\circ}\text{C}$ - $10^{\circ}\text{C}$ ) to Reserved .....                                                                                                                      | <b>32</b> |
| Changed $REG07$ Bit 4 from JEITA_VSET ( $45^{\circ}\text{C}$ to $60^{\circ}\text{C}$ ) to Reserved .....                                                                                                                    | <b>33</b> |
| Changed BOOT to BTST in <a href="#">Figure 38</a> .....                                                                                                                                                                     | <b>37</b> |
| Changed BOOT to BTST in <a href="#">Figure 39</a> .....                                                                                                                                                                     | <b>37</b> |
| Changed bq24193 to bq24192 in <a href="#">Figure 42</a> .....                                                                                                                                                               | <b>39</b> |

## 5 Description (Continued)

Its low impedance power path optimizes switch-mode operation efficiency, reduces battery charging time and extends battery life during discharging phase. The I<sup>2</sup>C serial interface with charging and system settings makes the device a truly flexible solution.

The device supports a wide range of input sources, including standard USB host port, USB charging port and high power DC adapter. To set the default input current limit, the bq24190 detects the input source following the USB battery charging spec 1.2, and the bq24192 and bq24192I take the results from detection circuit in the system, such as USB PHY device. The bq24190, 192, and 192I are compliant with USB 2.0 and USB 3.0 power specifications with input current and voltage regulation. Meanwhile, the bq24190, bq24192, and bq24192I meet USB On-the-Go operation power rating specification by supplying 5 V on the VBUS with a current limit up to 1.3 A.

The power path management regulates the system slightly above battery voltage but does not drop below 3.5-V minimum system voltage (programmable). With this feature, the system maintains operation even when the battery is completely depleted or removed. When the input current limit or voltage limit is reached, the power path management automatically reduces the charge current to zero. As the system load continues to increase, the power path discharges the battery until the system power requirement is met. This supplement mode operation prevents overloading the input source.

The devices initiate and complete a charging cycle without software control. It automatically detects the battery voltage and charges the battery in three phases: pre-conditioning, constant current and constant voltage. At the end of the charging cycle, the charger automatically terminates when the charge current is below a preset limit in the constant voltage phase. When the full battery falls below the recharge threshold, the charger will automatically start another charging cycle.

The bq24190, bq24192, and bq24192I provide various safety features for battery charging and system operation, including dual pack negative thermistor monitoring, charging safety timer and over-voltage/over-current protections. The thermal regulation reduces charge current when the junction temperature exceeds 120°C (programmable).

The STAT output reports the charging status and any fault conditions. The  $\overline{\text{PG}}$  output in the bq24192 and bq24192I indicates if a good power source is present. The INT immediately notifies the host when a fault occurs.

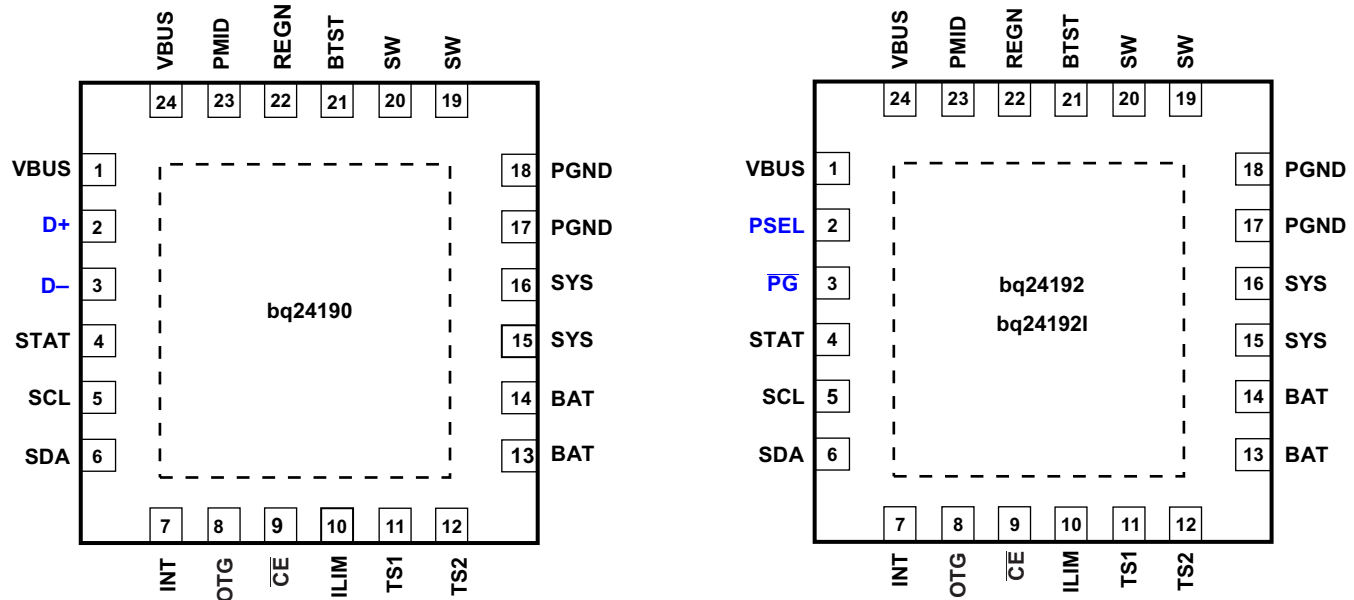
The bq24190, bq24192, and bq24192I are available in a 24-pin, 4.00 x 4.00 mm<sup>2</sup> thin VQFN package.

## 6 Device Comparison Table

|                               | <b>bq24190</b>        | <b>bq24192</b>               | <b>bq24192I</b>              |
|-------------------------------|-----------------------|------------------------------|------------------------------|
| I <sup>2</sup> C Address      | 6BH                   | 6BH                          | 6BH                          |
| USB Detection                 | D+/D–                 | PSEL                         | PSEL                         |
| Default VINDPM                | 4.36 V                | 4.36 V                       | 4.44 V                       |
| Default Battery Voltage       | 4.208 V               | 4.208 V                      | 4.112 V                      |
| Default Charge Current        | 2.048 A               | 2.048 A                      | 1.024 A                      |
| Default Adapter Current Limit | 1.5 A                 | 3 A                          | 1.5 A                        |
| Maximum Pre-Charge Current    | 2.048 A               | 2.048 A                      | 640 mA                       |
| Charging Temperature Profile  | Cold/Hot<br>2 TS pins | Cold/Hot<br>2 TS pins        | Cold/Hot<br>2 TS pins        |
| Status Output                 | STAT                  | STAT, $\overline{\text{PG}}$ | STAT, $\overline{\text{PG}}$ |
| STAT During Fault             | Blinking at 1 Hz      | Blinking at 1 Hz             | 10 k to ground               |

## 7 Pin Configuration and Functions

RGE Package  
24-Pin VQFN With Exposed Thermal Pad  
(Top View)



Blue pins indicate difference in pin names/functionality between devices.

### Pin Functions

| PIN             |                     | NUMBER | TYPE           | DESCRIPTION                                                                                                                                                                                                                                                                                                                               |
|-----------------|---------------------|--------|----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| bq24190         | bq24192<br>bq24192I |        |                |                                                                                                                                                                                                                                                                                                                                           |
| VBUS            | VBUS                | 1,24   | P              | Charger Input Voltage. The internal n-channel reverse block MOSFET (RBFET) is connected between VBUS and PMID with VBUS on source. Place a 1-μF ceramic capacitor from VBUS to PGND and place it as close as possible to IC. (Refer to Application Information Section for details)                                                       |
| D+              | –                   | 2      | I<br>Analog    | Positive line of the USB data line pair. D+/D– based USB host/charging port detection. The detection includes data contact detection (DCD) and primary detection in bc1.2.                                                                                                                                                                |
| –               | PSEL                | 2      | I<br>Digital   | Power source selection input. High indicates a USB host source and Low indicates an adapter source.                                                                                                                                                                                                                                       |
| D–              | –                   | 3      | I<br>Analog    | Negative line of the USB data line pair. D+/D– based USB host/charging port detection. The detection includes data contact detection (DCD) and primary detection in bc1.2.                                                                                                                                                                |
| –               | $\overline{PG}$     | 3      | O<br>Digital   | Open drain active low power good indicator. Connect to the pull up rail via 10-kΩ resistor. LOW indicates a good input source if the input voltage is between UVLO and ACOV, above SLEEP mode threshold, and current limit is above 30 mA.                                                                                                |
| STAT            | STAT                | 4      | O<br>Digital   | Open drain charge status output to indicate various charger operation. Connect to the pull up rail via 10-kΩ. LOW indicates charge in progress. HIGH indicates charge complete or charge disabled. When any fault condition occurs, STAT pin in bq24190, bq24192 blinks at 1 Hz, and STAT pin in bq24192I has a 10-kΩ resistor to ground. |
| SCL             | SCL                 | 5      | I<br>Digital   | I <sup>2</sup> C Interface clock. Connect SCL to the logic rail through a 10-kΩ resistor.                                                                                                                                                                                                                                                 |
| SDA             | SDA                 | 6      | I/O<br>Digital | I <sup>2</sup> C Interface data. Connect SDA to the logic rail through a 10-kΩ resistor.                                                                                                                                                                                                                                                  |
| INT             | INT                 | 7      | O<br>Digital   | Open-drain Interrupt Output. Connect the INT to a logic rail via 10-kΩ resistor. The INT pin sends active low, 256-μs pulse to host to report charger device status and fault.                                                                                                                                                            |
| OTG             | OTG                 | 8      | I<br>Digital   | USB current limit selection pin during buck mode, and active high enable pin during boost mode.<br>In buck mode with USB host (PSEL=High), when OTG = High, IIN limit = 500 mA and when OTG = Low, IIN limit = 100 mA.<br>The boost mode is activated when the REG01[5:4] = 10 and OTG pin is High.                                       |
| $\overline{CE}$ | CE                  | 9      | I<br>Digital   | Active low Charge Enable pin. Battery charging is enabled when REG01[5:4] = 01 and $\overline{CE}$ pin = Low. $\overline{CE}$ pin must be pulled high or low.                                                                                                                                                                             |

### Pin Functions (continued)

| PIN         |                     | NUMBER | TYPE        | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                           |
|-------------|---------------------|--------|-------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| bq24190     | bq24192<br>bq24192I |        |             |                                                                                                                                                                                                                                                                                                                                                                       |
| ILIM        | ILIM                | 10     | I<br>Analog | ILIM pin sets the maximum input current limit by regulating the ILIM voltage at 1 V. A resistor is connected from ILIM pin to ground to set the maximum limit as $I_{INMAX} = (1V/R_{ILIM}) \times 530$ . The actual input current limit is the lower one set by ILIM and by I <sup>2</sup> C REG00[2:0]. The minimum input current programmed on ILIM pin is 500 mA. |
| TS1         | TS1                 | 11     | I<br>Analog | Temperature qualification voltage input #1. Connect a negative temperature coefficient thermistor. Program temperature window with a resistor divider from REGN to TS1 to GND. Charge suspends when either TS pin is out of range. Recommend 103AT-2 thermistor.                                                                                                      |
| TS2         | TS2                 | 12     | I<br>Analog | Temperature qualification voltage input #2. Connect a negative temperature coefficient thermistor. Program temperature window with a resistor divider from REGN to TS2 to GND. Charge suspends when either TS pin is out of range. Recommend 103AT-2 thermistor.                                                                                                      |
| BAT         | BAT                 | 13,14  | P           | Battery connection point to the positive terminal of the battery pack. The internal BATFET is connected between BAT and SYS. Connect a 10 µF closely to the BAT pin.                                                                                                                                                                                                  |
| SYS         | SYS                 | 15,16  | P           | System connection point. The internal BATFET is connected between BAT and SYS. When the battery falls below the minimum system voltage, switch-mode converter keeps SYS above the minimum system voltage. (Refer to Application Information Section for inductor and capacitor selection.)                                                                            |
| PGND        | PGND                | 17,18  | P           | Power ground connection for high-current power converter node. Internally, PGND is connected to the source of the n-channel LSFET. On PCB layout, connect directly to ground connection of input and output capacitors of the charger. A single point connection is recommended between power PGND and the analog GND near the IC PGND pin.                           |
| SW          | SW                  | 19,20  | O<br>Analog | Switching node connecting to output inductor. Internally SW is connected to the source of the n-channel HSFET and the drain of the n-channel LSFET. Connect the 0.047-µF bootstrap capacitor from SW to BTST.                                                                                                                                                         |
| BTST        | BTST                | 21     | P           | PWM high side driver positive supply. Internally, the BTST is connected to the anode of the boost-strap diode. Connect the 0.047-µF bootstrap capacitor from SW to BTST.                                                                                                                                                                                              |
| REGN        | REGN                | 22     | P           | PWM low side driver positive supply output. Internally, REGN is connected to the cathode of the boost-strap diode. Connect a 4.7-µF (10-V rating) ceramic capacitor from REGN to analog GND. The capacitor should be placed close to the IC. REGN also serves as bias rail of TS1 and TS2 pins.                                                                       |
| PMID        | PMID                | 23     | O<br>Analog | Connected to the drain of the reverse blocking MOSFET and the drain of HSFET. Given the total input capacitance, connect a 1-µF capacitor on VBUS to PGND, and the rest all on PMID to PGND. (Refer to Application Information Section for details)                                                                                                                   |
| Thermal Pad | –                   | –      | P           | Exposed pad beneath the IC for heat dissipation. Always solder thermal pad to the board, and have vias on the thermal pad plane star-connecting to PGND and ground plane for high-current power converter.                                                                                                                                                            |

## 8 Specifications

### 8.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                                       |                                                                          | MIN   | MAX  | UNIT |
|---------------------------------------|--------------------------------------------------------------------------|-------|------|------|
| Voltage range (with respect to GND)   | VBUS                                                                     | –2    | 22   | V    |
|                                       | PMID                                                                     | –0.3  | 22   | V    |
|                                       | STAT, $\overline{PG}$                                                    | –0.3  | 20   | V    |
|                                       | BTST                                                                     | –0.3  | 26   | V    |
|                                       | SW                                                                       | –2    | 20   | V    |
|                                       | BAT, SYS (converter not switching)                                       | –0.3  | 6    | V    |
|                                       | SDA, SCL, INT, OTG, ILIM, REGN, TS1, TS2, $\overline{CE}$ , PSEL, D+, D– | –0.3  | 7    | V    |
|                                       | BTST TO SW                                                               | –0.3  | –7   | V    |
|                                       | PGND to GND                                                              | –0.3  | –0.3 | V    |
| Output sink current                   | INT, STAT, $\overline{PG}$                                               |       | 6    | mA   |
| Junction temperature                  |                                                                          | –40°C | 150  | °C   |
| Storage temperature, T <sub>stg</sub> |                                                                          | –65   | 150  | °C   |

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to the network ground terminal unless otherwise noted.

## 8.2 ESD Ratings

|             |                         |                                                                                | VALUE | UNIT |
|-------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 1000  | V    |
|             |                         | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 250   |      |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 8.3 Recommended Operating Conditions

|           |                                          | MIN | MAX                                                  | UNIT |
|-----------|------------------------------------------|-----|------------------------------------------------------|------|
| $V_{IN}$  | Input voltage                            | 3.9 | 17 <sup>(1)</sup>                                    | V    |
| $I_{IN}$  | Input current                            |     | 3                                                    | A    |
| $I_{SYS}$ | Output current (SYS)                     |     | 4.5                                                  | A    |
| $V_{BAT}$ | Battery voltage                          |     | 4.4                                                  | V    |
| $I_{BAT}$ | Fast charging current                    |     | 4.5                                                  | A    |
|           | Discharging current with internal MOSFET |     | 6 (continuous)<br>9 (peak)<br>(up to 1 sec duration) | A    |
| $T_A$     | Operating free-air temperature range     | –40 | 85                                                   | °C   |

(1) The inherent switching noise voltage spikes should not exceed the absolute maximum rating on either the BTST or SW pins. A tight layout minimizes switching noise.

## 8.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | bq2419x      | UNIT |
|-------------------------------|----------------------------------------------|--------------|------|
|                               |                                              | RGE (24 PIN) |      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 32.2         | °C/W |
| $R_{\theta JCTop}$            | Junction-to-case (top) thermal resistance    | 29.8         |      |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 9.1          |      |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.3          |      |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 9.1          |      |
| $R_{\theta JCbott}$           | Junction-to-case (bottom) thermal resistance | 2.2          |      |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 8.5 Electrical Characteristics

$V_{VBUS\_UVLOZ} < V_{VBUS} < V_{ACOV}$  and  $V_{VBUS} > V_{BAT} + V_{SLEEP}$ ,  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and  $T_J = 25^{\circ}\text{C}$  for typical values unless other noted.

| PARAMETER                 |                                          | TEST CONDITIONS                                                                                                       | MIN | TYP | MAX | UNIT |
|---------------------------|------------------------------------------|-----------------------------------------------------------------------------------------------------------------------|-----|-----|-----|------|
| <b>QUIESCENT CURRENTS</b> |                                          |                                                                                                                       |     |     |     |      |
| $I_{BAT}$                 | Battery discharge current (BAT, SW, SYS) | $V_{VBUS} < V_{UVLO}$ , $V_{BAT} = 4.2\text{ V}$ , leakage between BAT and VBUS                                       |     |     | 5   | μA   |
|                           |                                          | High-Z Mode, or no VBUS, BATFET disabled (REG07[5] = 1), $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$                |     | 12  | 20  | μA   |
|                           |                                          | High-Z Mode, or no VBUS, REG07[5] = 0, $-40^{\circ}\text{C}$ to $85^{\circ}\text{C}$                                  |     | 32  | 55  | μA   |
| $I_{VBUS}$                | Input supply current (VBUS)              | $V_{VBUS} = 5\text{ V}$ , High-Z mode                                                                                 |     | 15  | 30  | μA   |
|                           |                                          | $V_{VBUS} = 17\text{ V}$ , High-Z mode                                                                                |     | 30  | 50  | μA   |
|                           |                                          | $V_{VBUS} > V_{UVLO}$ , $V_{VBUS} > V_{BAT}$ , converter not switching                                                |     | 1.5 | 3   | mA   |
|                           |                                          | $V_{VBUS} > V_{UVLO}$ , $V_{VBUS} > V_{BAT}$ , converter switching, $V_{BAT} = 3.2\text{ V}$ , $I_{SYS} = 0\text{ A}$ |     | 4   |     | mA   |
|                           |                                          | $V_{VBUS} > V_{UVLO}$ , $V_{VBUS} > V_{BAT}$ , converter switching, $V_{BAT} = 3.8\text{ V}$ , $I_{SYS} = 0\text{ A}$ |     | 15  |     | mA   |
| $I_{OTGBOOST}$            | Battery discharge current in boost mode  | $V_{BAT} = 4.2\text{ V}$ , Boost mode, $I_{VBUS} = 0\text{ A}$ , converter switching                                  |     | 4   |     | mA   |

## Electrical Characteristics (continued)

$V_{VBUS\_UVLOZ} < V_{VBUS} < V_{ACOV}$  and  $V_{VBUS} > V_{BAT} + V_{SLEEP}$ ,  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and  $T_J = 25^{\circ}\text{C}$  for typical values unless other noted.

| PARAMETER                    |                                                                    | TEST CONDITIONS                                                                                              | MIN   | TYP  | MAX  | UNIT |
|------------------------------|--------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------|-------|------|------|------|
| <b>VBUS/BAT POWER UP</b>     |                                                                    |                                                                                                              |       |      |      |      |
| $V_{VBUS\_OP}$               | VBUS operating range                                               |                                                                                                              | 3.9   |      | 17   | V    |
| $V_{VBUS\_UVLOZ}$            | VBUS for active I <sup>2</sup> C, no battery                       | $V_{VBUS}$ rising                                                                                            | 3.6   |      |      | V    |
| $V_{SLEEP}$                  | Sleep mode falling threshold                                       | $V_{VBUS}$ falling, $V_{VBUS}-V_{BAT}$                                                                       | 35    | 80   | 120  | mV   |
| $V_{SLEEPZ}$                 | Sleep mode rising threshold                                        | $V_{VBUS}$ rising, $V_{VBUS}-V_{BAT}$                                                                        | 170   | 250  | 350  | mV   |
| $V_{ACOV}$                   | VBUS over-voltage rising threshold                                 | $V_{VBUS}$ rising                                                                                            | 17.4  | 18   |      | V    |
| $V_{ACOV\_HYST}$             | VBUS over-voltage falling hysteresis                               | $V_{VBUS}$ falling                                                                                           |       | 700  |      | mV   |
| $V_{BAT\_UVLOZ}$             | Battery for active I <sup>2</sup> C, no VBUS                       | $V_{BAT}$ rising                                                                                             | 2.3   |      |      | V    |
| $V_{BAT\_DPL}$               | Battery depletion threshold                                        | $V_{BAT}$ falling                                                                                            |       | 2.4  | 2.6  | V    |
| $V_{BAT\_DPL\_HY}$           | Battery depletion rising hysteresis                                | $V_{BAT}$ rising                                                                                             |       | 170  | 260  | mV   |
| $V_{VBUSMIN}$                | Bad adapter detection threshold                                    | $V_{VBUS}$ falling                                                                                           |       | 3.8  |      | V    |
| $I_{BADSRC}$                 | Bad adapter detection current source                               |                                                                                                              |       | 30   |      | mA   |
| $t_{BADSRC}$                 | Bad source detection duration                                      |                                                                                                              |       | 30   |      | ms   |
| <b>POWER PATH MANAGEMENT</b> |                                                                    |                                                                                                              |       |      |      |      |
| $V_{SYS\_RANGE}$             | Typical system regulation voltage                                  | $I_{SYS} = 0\text{ A}$ , Q4 off, $V_{BAT}$ up to 4.2 V, $REG01[3:1] = 101$ , $V_{SYSMIN} = 3.5\text{ V}$     | 3.5   |      | 4.35 | V    |
| $V_{SYS\_MIN}$               | System voltage output                                              | $REG01[3:1] = 101$ , $V_{SYSMIN} = 3.5\text{ V}$                                                             | 3.55  | 3.65 |      | V    |
| $R_{ON(RBFET)}$              | Internal top reverse blocking MOSFET on-resistance                 | Measured between VBUS and PMID                                                                               |       | 23   | 38   | mΩ   |
| $R_{ON(HSFET)}$              | Internal top switching MOSFET on-resistance between PMID and SW    | $T_J = -40^{\circ}\text{C}$ to $85^{\circ}\text{C}$                                                          |       | 27   | 35   | mΩ   |
|                              |                                                                    | $T_J = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$                                                         |       | 27   | 45   |      |
| $R_{ON(LSFET)}$              | Internal bottom switching MOSFET on-resistance between SW and PGND | $T_J = -40^{\circ}\text{C}$ to $85^{\circ}\text{C}$                                                          |       | 32   | 45   | mΩ   |
|                              |                                                                    | $T_J = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$                                                         |       | 32   | 48   |      |
| $V_{FWD}$                    | BATFET forward voltage in supplement mode                          | BAT discharge current 10 mA                                                                                  |       | 30   |      | mV   |
| $V_{SYS\_BAT}$               | SYS/BAT Comparator                                                 | $V_{SYS}$ falling                                                                                            |       | 90   |      | mV   |
| $V_{BATGD}$                  | Battery good comparator rising threshold                           | $V_{BAT}$ rising                                                                                             |       | 3.55 |      | V    |
| $V_{BATGD\_HYST}$            | Battery good comparator falling threshold                          | $V_{BAT}$ falling                                                                                            |       | 100  |      | mV   |
| <b>BATTERY CHARGER</b>       |                                                                    |                                                                                                              |       |      |      |      |
| $V_{BAT\_REG\_ACC}$          | Charge voltage regulation accuracy                                 | $V_{BAT} = 4.112\text{ V}$ and $4.208\text{ V}$                                                              | -0.5% |      | 0.5% |      |
| $I_{CHG\_REG\_ACC}$          | Fast charge current regulation accuracy                            | $V_{BAT} = 3.8\text{ V}$ , $I_{CHG} = 1792\text{ mA}$ , $T_J = 25^{\circ}\text{C}$                           | -4%   |      | 4%   |      |
|                              |                                                                    | $V_{BAT} = 3.8\text{ V}$ , $I_{CHG} = 1792\text{ mA}$ , $T_J = -20^{\circ}\text{C}$ to $125^{\circ}\text{C}$ | -7%   |      | 7%   |      |
| $I_{CHG\_20pct}$             | Charge current with 20% option on                                  | $V_{BAT} = 3.1\text{ V}$ , $I_{CHG} = 104\text{ mA}$ , $REG02 = 03$                                          | 75    | 100  | 150  | mA   |
| $V_{BATLOWV}$                | Battery LOWV falling threshold                                     | Fast charge to precharge, $REG04[1] = 1$                                                                     | 2.6   | 2.8  | 2.9  | V    |
| $V_{BATLOWV\_HYST}$          | Battery LOWV rising threshold                                      | Precharge to fast charge, $REG04[1] = 1$                                                                     | 2.8   | 3.0  | 3.1  | V    |
| $I_{PRECHG\_ACC}$            | Precharge current regulation accuracy                              | $V_{BAT} = 2.6\text{ V}$ , $I_{CHG} = 256\text{ mA}$                                                         | -20%  |      | 20%  |      |
| $I_{TERM\_ACC}$              | Termination current accuracy                                       | $I_{TERM} = 256\text{ mA}$ , $I_{CHG} = 960\text{ mA}$                                                       | -20%  |      | 20%  |      |
| $V_{SHORT}$                  | Battery Short Voltage                                              | $V_{BAT}$ falling                                                                                            |       | 2.0  |      | V    |
| $V_{SHORT\_HYST}$            | Battery Short Voltage hysteresis                                   | $V_{BAT}$ rising                                                                                             |       | 200  |      | mV   |
| $I_{SHORT}$                  | Battery short current                                              | $V_{BAT} < 2.2\text{ V}$                                                                                     |       | 100  |      | mA   |
| $V_{RECHG}$                  | Recharge threshold below $V_{BAT\_REG}$                            | $V_{BAT}$ falling, $REG04[0] = 0$                                                                            |       | 100  |      | mV   |
| $t_{RECHG}$                  | Recharge deglitch time                                             | $V_{BAT}$ falling, $REG04[0] = 0$                                                                            |       | 20   |      | ms   |
| $R_{ON\_BATFET}$             | SYS-BAT MOSFET on-resistance                                       | $T_J = 25^{\circ}\text{C}$                                                                                   |       | 12   | 15   | mΩ   |
|                              |                                                                    | $T_J = -40^{\circ}\text{C}$ to $125^{\circ}\text{C}$                                                         |       | 12   | 20   |      |

# bq24190, bq24192, bq24192I

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## Electrical Characteristics (continued)

$V_{VBUS\_UVLOZ} < V_{VBUS} < V_{ACOV}$  and  $V_{VBUS} > V_{BAT} + V_{SLEEP}$ ,  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and  $T_J = 25^{\circ}\text{C}$  for typical values unless other noted.

| PARAMETER                                                        |                                                                                     | TEST CONDITIONS                                                    | MIN   | TYP   | MAX   | UNIT               |
|------------------------------------------------------------------|-------------------------------------------------------------------------------------|--------------------------------------------------------------------|-------|-------|-------|--------------------|
| <b>INPUT VOLTAGE/CURRENT REGULATION</b>                          |                                                                                     |                                                                    |       |       |       |                    |
| $V_{INDPM\_REG\_ACC}$                                            | Input voltage regulation accuracy                                                   | REG00[6:3] = 0110 (4.36 V) or 1011 (4.76 V)                        | -2%   |       | 2%    |                    |
| $I_{USB\_DPM}$                                                   | USB Input current regulation limit, $V_{BUS} = 5\text{ V}$ , current pulled from SW | USB100                                                             | 85    |       | 100   | mA                 |
|                                                                  |                                                                                     | USB150                                                             | 125   |       | 150   | mA                 |
|                                                                  |                                                                                     | USB500                                                             | 440   |       | 500   | mA                 |
|                                                                  |                                                                                     | USB900                                                             | 750   |       | 900   | mA                 |
| $I_{ADPT\_DPM}$                                                  | Input current regulation accuracy                                                   | Typical input current of 1.5 A based on KLIM                       | 1.35  | 1.5   | 1.65  | A                  |
| $I_{IN\_START}$                                                  | Input current limit during system start up                                          | $V_{SYS} < 2.2\text{ V}$                                           |       | 100   |       | mA                 |
| $K_{ILIM}$                                                       | $I_{IN} = K_{ILIM}/R_{ILIM}$                                                        | $I_{INDPM} = 1.5\text{ A}$                                         | 435   | 485   | 530   | A x $\Omega$       |
| <b>D+/D- DETECTION</b>                                           |                                                                                     |                                                                    |       |       |       |                    |
| $V_{D+\_SRC}$                                                    | D+ voltage source                                                                   |                                                                    | 0.5   | 0.6   | 0.7   | V                  |
| $I_{D+\_SRC}$                                                    | D+ connection check current source                                                  |                                                                    | 7     |       | 14    | $\mu\text{A}$      |
| $I_{D-\_SINK}$                                                   | D- current sink                                                                     |                                                                    | 50    | 100   | 150   | $\mu\text{A}$      |
| $I_{D\_LKG}$                                                     | Leakage current into D+/D-                                                          | D-, switch open                                                    | -1    |       | 1     | $\mu\text{A}$      |
|                                                                  |                                                                                     | D+, switch open                                                    | -1    |       | 1     | $\mu\text{A}$      |
| $V_{D+\_LOW}$                                                    | D+ Low comparator threshold                                                         |                                                                    | 0.7   |       | 0.8   | V                  |
| $V_{D-\_LOWdatref}$                                              | D- Low comparator threshold                                                         |                                                                    | 250   |       | 400   | mV                 |
| $R_{D-\_DWN}$                                                    | D- Pulldown for connection check                                                    |                                                                    | 14.25 |       | 24.8  | k $\Omega$         |
| $t_{SDP\_DEFAULT}$                                               | Charging timer with 100-mA USB host in default mode                                 |                                                                    |       |       | 45    | mins               |
| <b>BAT OVER-VOLTAGE PROTECTION</b>                               |                                                                                     |                                                                    |       |       |       |                    |
| $V_{BATOV}$                                                      | Battery over-voltage threshold                                                      | $V_{BAT}$ rising, as percentage of $V_{BAT\_REG}$                  |       | 104%  |       |                    |
| $V_{BATOV\_HYST}$                                                | Battery over-voltage hysteresis                                                     | $V_{BAT}$ falling, as percentage of $V_{BAT\_REG}$                 |       | 2%    |       |                    |
| $t_{BATOV}$                                                      | Battery over-voltage deglitch time to disable charge                                |                                                                    |       | 1     |       | $\mu\text{s}$      |
| <b>THERMAL REGULATION AND THERMAL SHUTDOWN</b>                   |                                                                                     |                                                                    |       |       |       |                    |
| $T_{Junction\_REG}$                                              | Junction temperature regulation accuracy                                            | REG06[1:0] = 11                                                    |       | 120   |       | $^{\circ}\text{C}$ |
| $T_{SHUT}$                                                       | Thermal shutdown rising temperature                                                 | Temperature increasing                                             |       | 160   |       | $^{\circ}\text{C}$ |
| $T_{SHUT\_HYS}$                                                  | Thermal shutdown hysteresis                                                         |                                                                    |       | 30    |       | $^{\circ}\text{C}$ |
|                                                                  | Thermal shutdown rising deglitch                                                    | Temperature increasing delay                                       |       | 1     |       | ms                 |
|                                                                  | Thermal shutdown falling deglitch                                                   | Temperature decreasing delay                                       |       | 1     |       | ms                 |
| <b>COLD/HOT THERMISTOR COMPARATOR (bq24190,bq24192,bq24192I)</b> |                                                                                     |                                                                    |       |       |       |                    |
| $V_{LTF}$                                                        | Cold temperature threshold, TS pin voltage rising threshold                         | Charger suspends charge. As percentage to $V_{REGN}$               | 73%   | 73.5% | 74%   |                    |
| $V_{LTF\_HYS}$                                                   | Cold temperature hysteresis, TS pin voltage falling                                 | As percentage to $V_{REGN}$                                        | 0.2%  | 0.4%  | 0.6%  |                    |
| $V_{HTF}$                                                        | Hot temperature TS pin voltage rising threshold                                     | As percentage to $V_{REGN}$                                        | 46.6% | 47.2% | 48.8% |                    |
| $V_{TCO}$                                                        | Cut-off temperature TS pin voltage falling threshold                                | As percentage to $V_{REGN}$                                        | 44.2% | 44.7% | 45.2% |                    |
|                                                                  | Deglitch time for temperature out of range detection                                | $V_{TS} > V_{LTF}$ , or $V_{TS} < V_{TCO}$ , or $V_{TS} < V_{HTF}$ |       | 10    |       | ms                 |
| <b>CHARGE OVER-CURRENT COMPARATOR</b>                            |                                                                                     |                                                                    |       |       |       |                    |
| $I_{HSFET\_OCP}$                                                 | HSFET over-current threshold                                                        |                                                                    | 5.3   | 7     |       | A                  |
| $I_{BATFET\_OCP}$                                                | System over load threshold                                                          |                                                                    | 9     |       |       | A                  |
| <b>CHARGE UNDER-CURRENT COMPARATOR (CYCLE-BY-CYCLE)</b>          |                                                                                     |                                                                    |       |       |       |                    |
| $V_{LSFET\_UCP}$                                                 | LSFET charge under-current falling threshold                                        | From sync mode to non-sync mode                                    |       | 100   |       | mA                 |
| <b>PWM OPERATION</b>                                             |                                                                                     |                                                                    |       |       |       |                    |
| $F_{SW}$                                                         | PWM Switching frequency, and digital clock                                          |                                                                    | 1300  | 1500  | 1700  | kHz                |
| $D_{MAX}$                                                        | Maximum PWM duty cycle                                                              |                                                                    |       | 97%   |       |                    |

## Electrical Characteristics (continued)

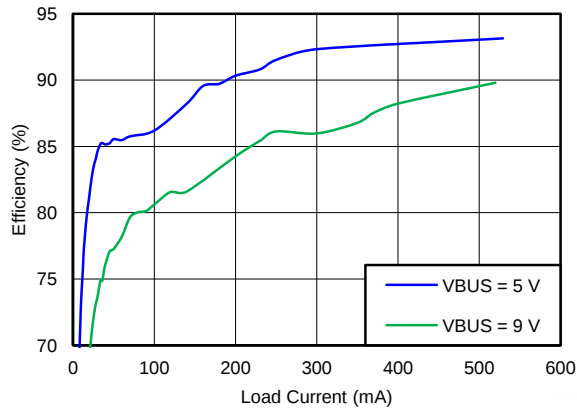
$V_{VBUS\_UVLOZ} < V_{VBUS} < V_{ACOV}$  and  $V_{VBUS} > V_{BAT} + V_{SLEEP}$ ,  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  and  $T_J = 25^{\circ}\text{C}$  for typical values unless other noted.

| PARAMETER                                                                                         |                                        | TEST CONDITIONS                                             | MIN  | TYP  | MAX  | UNIT |
|---------------------------------------------------------------------------------------------------|----------------------------------------|-------------------------------------------------------------|------|------|------|------|
| V <sub>BTST_REFRESH</sub>                                                                         | Bootstrap refresh comparator threshold | VBTST-VSW when LSFET refresh pulse is requested, VBUS = 5 V | 3.6  |      |      | V    |
|                                                                                                   |                                        | VBTST-VSW when LSFET refresh pulse is requested, VBUS > 6 V | 4.5  |      |      |      |
| BOOST MODE OPERATION                                                                              |                                        |                                                             |      |      |      |      |
| V <sub>OTG_REG</sub>                                                                              | OTG output voltage                     | I(VBUS) = 0                                                 | 5.00 |      |      | V    |
| V <sub>OTG_REG_ACC</sub>                                                                          | OTG output voltage accuracy            | I(VBUS) = 0                                                 | −2%  | 2%   |      |      |
| I <sub>OTG</sub>                                                                                  | OTG mode output current                | REG01[0] = 0                                                | 0.5  |      |      | A    |
|                                                                                                   |                                        | REG01[0] = 1                                                | 1.3  |      |      | A    |
| V <sub>OTG_OVP</sub>                                                                              | OTG over-voltage threshold             |                                                             | 5.3  |      | 5.5  | V    |
| I <sub>OTG_ILIM</sub>                                                                             | LSFET cycle-by-cycle current limit     |                                                             | 3.2  | 4.6  |      | A    |
| I <sub>OTG_HSZCP</sub>                                                                            | HSFET under current falling threshold  |                                                             | 100  |      |      | mA   |
| I <sub>RBFET_OCP</sub>                                                                            | RBFET over-current threshold           | REG01[0] = 1                                                | 1.4  | 1.8  | 2.7  | A    |
|                                                                                                   |                                        | REG01[0] = 0                                                | 0.6  | 1.1  | 1.8  |      |
| REGN LDO                                                                                          |                                        |                                                             |      |      |      |      |
| V <sub>REGN</sub>                                                                                 | REGN LDO output voltage                | V <sub>VBUS</sub> = 10 V, I <sub>REGN</sub> = 40 mA         | 5.6  | 6    | 6.4  | V    |
|                                                                                                   |                                        | V <sub>VBUS</sub> = 5 V, I <sub>REGN</sub> = 20 mA          | 4.75 | 4.8  |      | V    |
| I <sub>REGN</sub>                                                                                 | REGN LDO current limit                 | V <sub>VBUS</sub> = 10 V, V <sub>REGN</sub> = 3.8 V         | 50   |      |      | mA   |
| LOGIC I/O PIN CHARACTERISTICS (OTG, $\overline{\text{CE}}$ , PSEL, STAT, $\overline{\text{PG}}$ ) |                                        |                                                             |      |      |      |      |
| V <sub>ILO</sub>                                                                                  | Input low threshold                    |                                                             | 0.4  |      |      | V    |
| V <sub>IH</sub>                                                                                   | Input high threshold                   |                                                             | 1.3  |      |      | V    |
| V <sub>OUT_LO</sub>                                                                               | Output low saturation voltage          | Sink current = 5 mA                                         | 0.4  |      |      | V    |
| I <sub>BIAS</sub>                                                                                 | High level leakage current             | Pull up rail 1.8 V                                          | 1    |      |      | μA   |
| I <sup>2</sup> C INTERFACE (SDA, SCL, INT)                                                        |                                        |                                                             |      |      |      |      |
| V <sub>IH</sub>                                                                                   | Input high threshold level             | VPULL-UP = 1.8 V, SDA and SCL                               | 1.3  |      |      | V    |
| V <sub>IL</sub>                                                                                   | Input low threshold level              | VPULL-UP = 1.8 V, SDA and SCL                               | 0.4  |      |      | V    |
| V <sub>OL</sub>                                                                                   | Output low threshold level             | Sink current = 5 mA                                         | 0.4  |      |      | V    |
| I <sub>BIAS</sub>                                                                                 | High-level leakage current             | VPULL-UP = 1.8 V, SDA and SCL                               | 1    |      |      | μA   |
| f <sub>SCL</sub>                                                                                  | SCL clock frequency                    |                                                             | 400  |      |      | kHz  |
| DIGITAL CLOCK AND WATCHDOG TIMER                                                                  |                                        |                                                             |      |      |      |      |
| f <sub>HIZ</sub>                                                                                  | Digital crude clock                    | REGN LDO disabled                                           | 15   | 35   | 50   | kHz  |
| f <sub>DIG</sub>                                                                                  | Digital clock                          | REGN LDO enabled                                            | 1300 | 1500 | 1700 | kHz  |
| t <sub>WDT</sub>                                                                                  | REG05[5:4] = 11                        | REGN LDO enabled                                            | 136  | 160  |      | sec  |

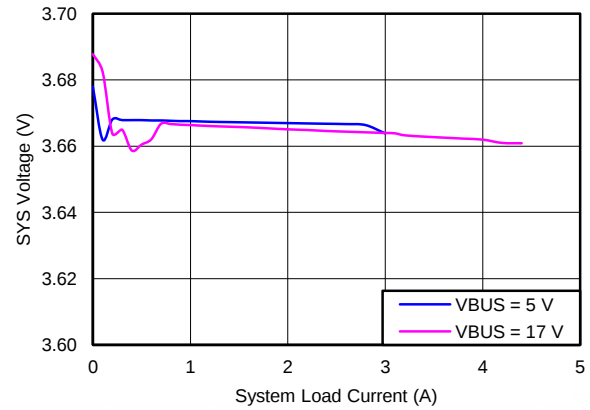
## 8.6 Typical Characteristics

**Table 1. Table of Figures**

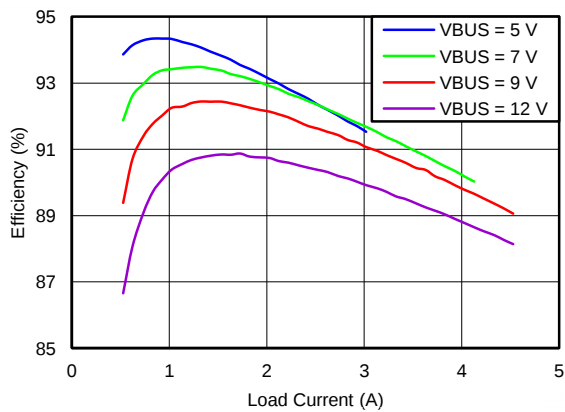
|                                                         | FIGURE NO.               |
|---------------------------------------------------------|--------------------------|
| System Light Load Efficiency vs System Load Current     | <a href="#">Figure 1</a> |
| SYS Voltage Regulation vs System Load                   | <a href="#">Figure 2</a> |
| Charging Efficiency vs Charging Current                 | <a href="#">Figure 3</a> |
| Boost Mode Efficiency vs VBUS Load Current              | <a href="#">Figure 4</a> |
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| SYS Voltage vs Temperature                              | <a href="#">Figure 6</a> |
| BAT Voltage vs Temperature                              | <a href="#">Figure 7</a> |
| Input Current Limit vs Temperature                      | <a href="#">Figure 8</a> |
| Charge Current vs Temperature                           | <a href="#">Figure 9</a> |



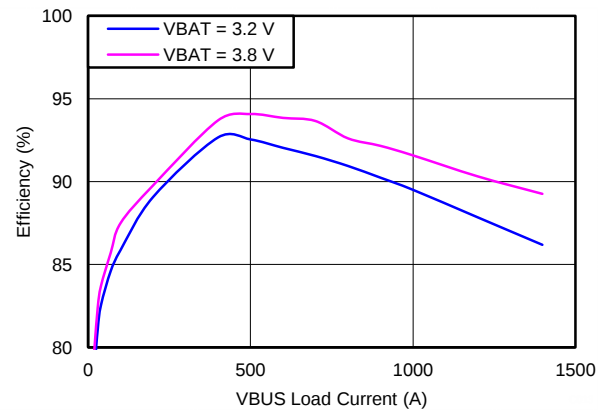
**Figure 1. System Light Load Efficiency vs System Load Current**



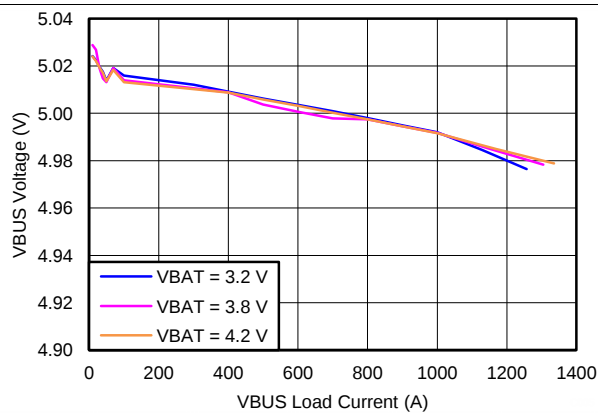
**Figure 2. SYS Voltage Regulation vs System Load**



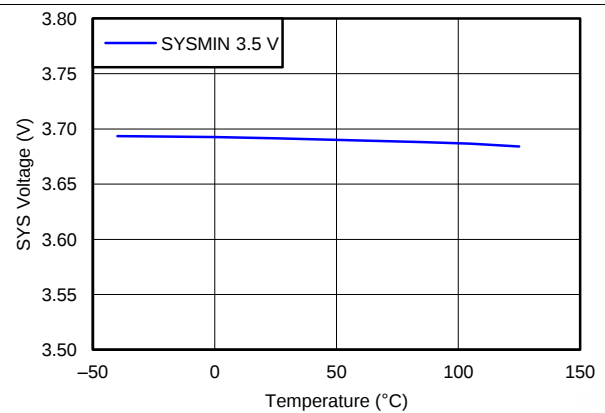
**Figure 3. Charging Efficiency vs Charging Current**



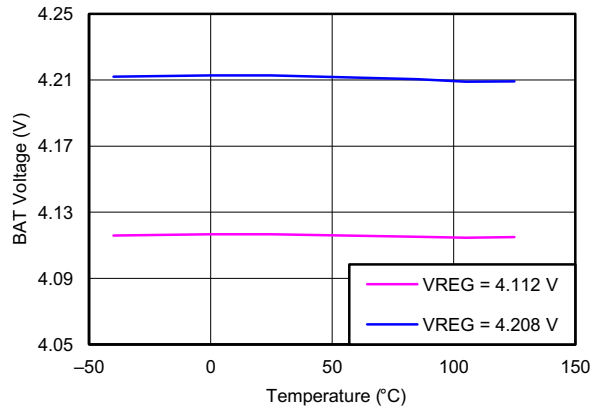
**Figure 4. Boost Mode Efficiency vs VBUS Load Current**



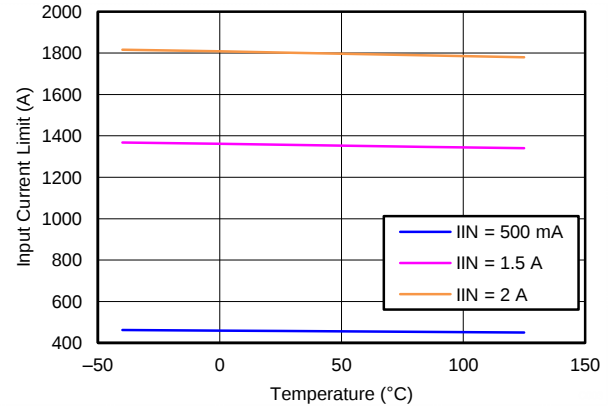
**Figure 5. Boost Mode VBUS Voltage Regulation vs VBUS Load Current**



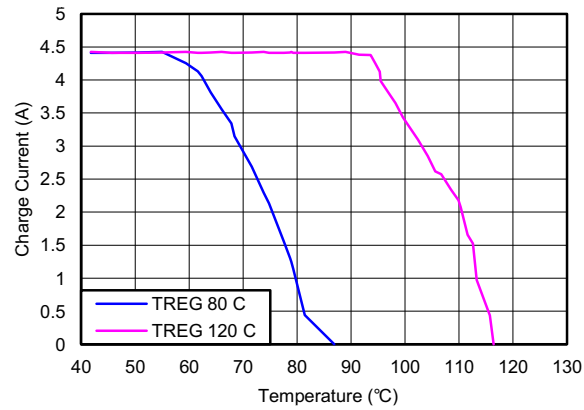
**Figure 6. SYS Voltage vs Temperature**



**Figure 7. BAT Voltage vs Temperature**



**Figure 8. Input Current Limit vs Temperature**



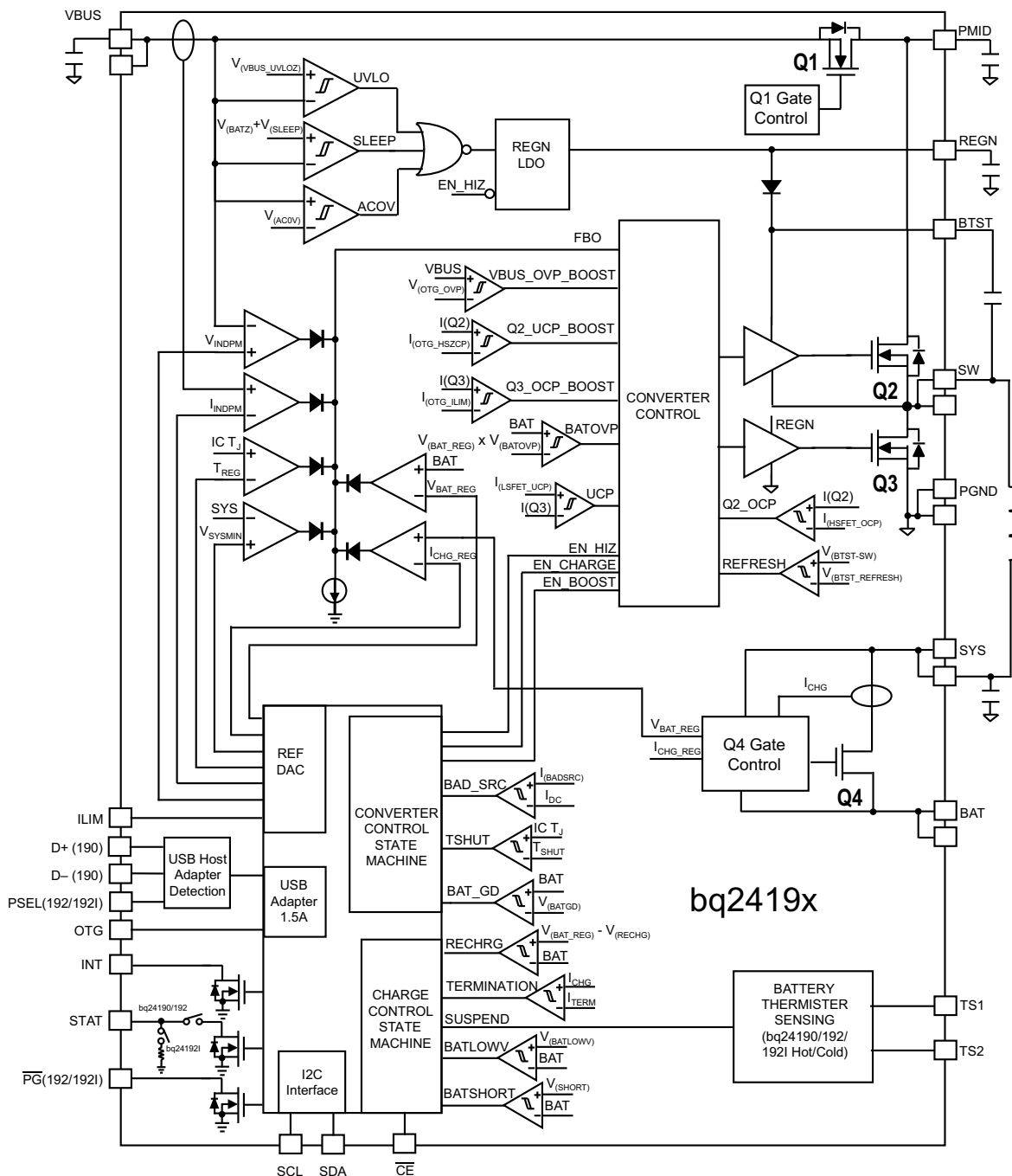
**Figure 9. Charge Current vs Temperature**

## 9 Detailed Description

### 9.1 Overview

The bq24190, bq24192, bq24192I is an I<sup>2</sup>C controlled power path management device and a single cell Li-Ion battery charger. It integrates the input reverse-blocking FET (RBFET, Q1), high-side switching FET (HSFET, Q2), low-side switching FET (LSFET, Q3), and BATFET (Q4) between system and battery. The device also integrates the bootstrap diode for the high-side gate drive.

### 9.2 Functional Block Diagram



## 9.3 Feature Description

### 9.3.1 Device Power Up

#### 9.3.1.1 Power-On-Reset (POR)

The internal bias circuits are powered from the higher voltage of VBUS and BAT. When VBUS or VBAT rises above UVLOZ, the sleep comparator, battery depletion comparator and BATFET driver are active. I<sup>2</sup>C interface is ready for communication and all the registers are reset to default value. The host can access all the registers after POR.

#### 9.3.1.2 Power Up from Battery without DC Source

If only battery is present and the voltage is above depletion threshold ( $V_{BAT\_DEPL}$ ), the BATFET turns on and connects battery to system. The REGN LDO stays off to minimize the quiescent current. The low  $R_{DS(on)}$  in BATFET and the low quiescent current on BAT minimize the conduction loss and maximize the battery run time. The device always monitors the discharge current through BATFET. When the system is overloaded or shorted, the device will immediately turn off BATFET and keep BATFET off until the input source plugs in again.

##### 9.3.1.2.1 BATFET Turn Off

The BATFET can be forced off by the host through I<sup>2</sup>C REG07[5]. This bit allows the user to independently turn off the BATFET when the battery condition becomes abnormal during charging. When BATFET is off, there is no path to charge or discharge the battery.

When battery is not attached, the BATFET should be turned off by setting REG07[5] to 1 to disable charging and supplement mode.

##### 9.3.1.2.2 Shipping Mode

When end equipment is assembled, the system is connected to battery through BATFET. There will be a small leakage current to discharge the battery even when the system is powered off. In order to extend the battery life during shipping and storage, the device can turn off BATFET so that the system voltage is zero to minimize the leakage.

In order to keep BATFET off during shipping mode, the host has to disable the watchdog timer (REG05[5:4] = 00) and disable BATFET (REG07[5] = 1) at the same time.

Once the BATFET is disabled, the BATFET can be turned on by plugging in adapter.

#### 9.3.1.3 Power Up from DC Source

When the DC source plugs in, the bq24190, bq24192, bq24192I checks the input source voltage to turn on REGN LDO and all the bias circuits. It also checks the input current limit before starts the buck converter.

##### 9.3.1.3.1 REGN LDO

The REGN LDO supplies internal bias circuits as well as the HSFET and LSFET gate drive. The LDO also provides bias rail to TS1/TS2 external resistors. The pull-up rail of STAT and PG can be connected to REGN as well.

The REGN is enabled when all the conditions are valid.

1. VBUS above UVLOZ
2. VBUS above battery +  $V_{SLEEPZ}$  in buck mode or VBUS below battery +  $V_{SLEEPZ}$  in boost mode
3. After typical 220ms delay (100ms minimum) is complete

If one of the above conditions is not valid, the device is in high impedance mode (HIZ) with REGN LDO off. The device draws less than 50  $\mu$ A from VBUS during HIZ state. The battery powers up the system when the device is in HIZ.

##### 9.3.1.3.2 Input Source Qualification

After REGN LDO powers up, the bq24190, bq24192, bq24192I checks the current capability of the input source. The input source has to meet the following requirements to start the buck converter.

## Feature Description (continued)

1. VBUS voltage below 18 V (not in ACOV)
2. VBUS voltage above 3.8 V when pulling 30 mA (poor source detection)

Once the input source passes all the conditions above, the status register REG08[2] goes high and the  $\overline{\text{PG}}$  pin (bq24192, bq24192I) goes low. An INT is asserted to the host.

If the device fails the poor source detection, it will repeat the detection every 2 seconds.

### 9.3.1.3.3 Input Current Limit Detection

The USB ports on personal computers are convenient charging source for portable devices (PDs). If the portable device is attached to a USB host, the USB specification requires the portable device to draw limited current (100 mA/500 mA in USB 2.0, and 150 mA/900 mA in USB 3.0). If the portable device is attached to a charging port, it is allowed to draw up to 1.5 A.

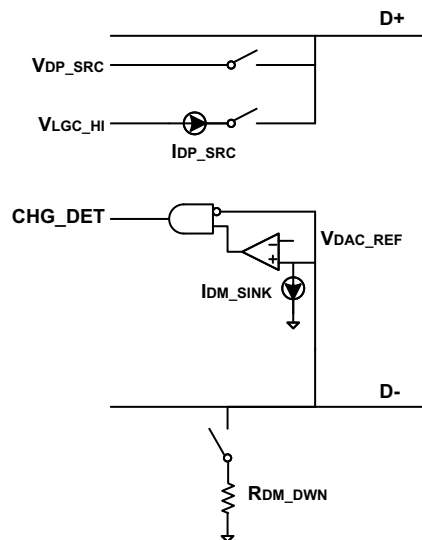
After the  $\overline{\text{PG}}$  is LOW or REG08[2] goes HIGH, the charger device always runs input current limit detection when a DC source plugs in unless the charger is in HIZ during host mode.

The bq24190 follows battery charging specification 1.2 (bc1.2) to detect input source through USB D+/D– lines. The bq24192 and bq24192I set input current limit through PSEL and OTG pins.

After the input current limit detection is done, the host can write to REG00[2:0] to change the input current limit.

### 9.3.1.3.4 D+/D– Detection Sets Input Current Limit in bq24190

The bq24190 contains a D+/D– based input source detection to program the input current limit. The D+/D– detection has two steps: data contact detect (DCD) followed by primary detection.



**Figure 10. USB D+/D– Detection**

DCD (Data Contact Detection) uses a current source to detect when the D+/D– pins have made contact during an attach event. The protocol for data contact detect is as follows:

- Detect VBUS present and REG08[2] = 1 (power good)
- Turn on D+  $I_{\text{DP\_SRC}}$  and the D– pull-down resistor  $R_{\text{DM\_DWN}}$  for 40 ms
- If the USB connector is properly attached, the D+ line goes from HIGH to LOW, wait up to 0.5 sec.
- Turn off  $I_{\text{DP\_SRC}}$  and disconnect  $R_{\text{DM\_DWN}}$

The primary detection is used to distinguish between USB host (Standard Down Stream Port, or SDP) and different type of charging ports (Charging Down Stream Port, or CDP, and Dedicated Charging Port, or DCP). The protocol for primary detection is as follows:

- Turn on  $V_{\text{DP\_SRC}}$  on D+ and  $I_{\text{DM\_SINK}}$  on D– for 40 ms

## Feature Description (continued)

- If PD is attached to a USB host (SDP), the D– is low. If PD is attached to a charging port (CDP or DCP), the D– is high
- Turn off  $V_{DP\_SRC}$  and  $I_{DM\_SINK}$

Table 2 shows the input current limit setting after D+/D– detection.

**Table 2. bq24190 USB D+/D– Detection**

| D+/D– DETECTION                               | OTG  | INPUT CURRENT LIMIT | REG08[7:6] |
|-----------------------------------------------|------|---------------------|------------|
| 0.5 sec timer expired in DCD (D+/D– floating) | —    | 100 mA              | 00         |
| USB host                                      | LOW  | 100 mA              | 01         |
| USB host                                      | HIGH | 500 mA              | 01         |
| Charging port                                 | —    | 1.5 A               | 10         |

### 9.3.1.3.5 PSEL/OTG Pins Set Input Current Limit in bq24192, bq24192I

The bq24192 and bq24192I has PSEL instead of D+/D–. It directly takes the USB PHY device output to decide whether the input is USB host or charging port.

**Table 3. bq24192, bq24192I Input Current Limit Detection**

| PSEL | OTG  | INPUT CURRENT LIMIT               | REG08[7:6] |
|------|------|-----------------------------------|------------|
| HIGH | LOW  | 100 mA                            | 01         |
| HIGH | HIGH | 500 mA                            | 01         |
| LOW  | —    | 1.5 A (bq24192I)<br>3 A (bq24192) | 10         |

### 9.3.1.3.6 HIZ State wth 100mA USB Host

In battery charging spec, the good battery threshold is the minimum charge level of a battery to power up the portable device successfully. When the input source is 100-mA USB host, and the battery is above bat-good threshold ( $V_{BATGD}$ ), the device follows battery charging spec and enters high impedance state (HIZ). In HIZ state, the device is in the lowest quiescent state with REGN LDO and the bias circuits off. The charger device sets REG00[7] to 1, and the VBUS current during HIZ state will be less than 30  $\mu$ A. The system is supplied by the battery.

Once the charger device enters HIZ state in host mode, it stays in HIZ until the host writes REG00[7] = 0. When the processor host wakes up, it is recommended to first check if the charger is in HIZ state.

In default mode, the charger IC will reset REG00[7] back to 0 when input source is removed. When another source plugs in, the charger IC will run detection again, and update the input current limit.

### 9.3.1.3.7 Force Input Current Limit Detection

The host can force the charger device to run input current limit detection by setting REG07[7] = 1. After the detection is complete, REG07[7] will return to 0 by itself.

### 9.3.1.4 Converter Power-Up

After the input current limit is set, the converter is enabled and the HSFET and LSFET start switching. If battery charging is disabled, BATFET turns off. Otherwise, BATFET stays on to charge the battery.

The bq24190, bq24192, bq24192I provides soft-start when ramp up the system rail. When the system rail is below 2.2 V, the input current limit is forced to 100 mA. After the system rises above 2.2 V, the charger device sets the input current limit set by the lower value between register and ILIM pin.

As a battery charger, the bq24190, bq24192, bq24192I deploys a 1.5-MHz step-down switching regulator. The fixed frequency oscillator keeps tight control of the switching frequency under all conditions of input voltage, battery voltage, charge current and temperature, simplifying output filter design.

A type III compensation network allows using ceramic capacitors at the output of the converter. An internal saw-tooth ramp is compared to the internal error control signal to vary the duty cycle of the converter. The ramp height is proportional to the PMID voltage to cancel out any loop gain variation due to a change in input voltage.

In order to improve light-load efficiency, the device switches to PFM control at light load when battery is below minimum system voltage setting or charging is disabled. During the PFM operation, the switching duty cycle is set by the ratio of SYS and VBUS.

### **9.3.1.5 Boost Mode Operation from Battery**

The bq24190, bq24192, bq24192I supports boost converter operation to deliver power from the battery to other portable devices through USB port. The boost mode output current rating meets the USB On-The-Go 500-mA output requirement. The maximum output current is 1.3 A. The boost operation can be enabled if the following conditions are valid:

1. BAT above BATLOWV threshold ( $V_{BATLOWV}$  set by REG04[1])
2. VBUS less than  $BAT + V_{SLEEP}$  (in sleep mode)
3. Boost mode operation is enabled (OTG pin HIGH and REG01[5:4] = 10)
4. After 220-ms delay from boost mode enable

In boost mode, the bq24190, bq24192, bq24192I employs a 1.5-MHz step-up switching regulator. Similar to buck operation, the device switches from PWM operation to PFM operation at light load to improve efficiency.

During boost mode, the status register REG08[7:6] is set to 11, the VBUS output is 5 V and the output current can reach up to 500 mA or 1.3 A, selected via I<sup>2</sup>C (REG01[0]).

Any fault during boost operation, including VBUS over-voltage or over-current, sets the fault register REG09[6] to 1 and an INT is asserted.

## **9.3.2 Power Path Management**

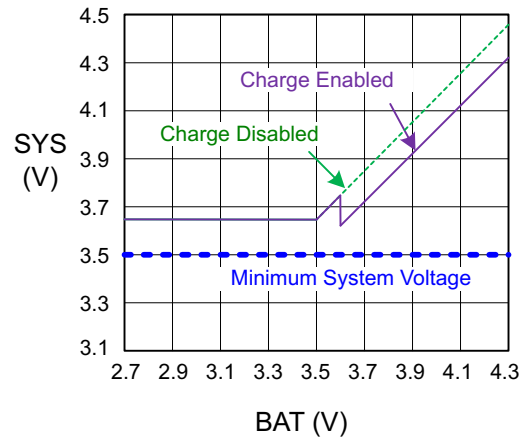
The bq24190, bq24192, bq24192I accommodates a wide range of input sources from USB, wall adapter, to car battery. The device provides automatic power path selection to supply the system (SYS) from input source (VBUS), battery (BAT), or both.

### **9.3.2.1 Narrow VDC Architecture**

The device deploys Narrow VDC architecture (NVDC) with BATFET separating system from battery. The minimum system voltage is set by REG01[3:1]. Even with a fully depleted battery, the system is regulated above the minimum system voltage (default 3.5 V).

When the battery is below minimum system voltage setting, the BATFET operates in linear mode (LDO mode), and the system is 150 mV above the minimum system voltage setting. As the battery voltage rises above the minimum system voltage, BATFET is fully on and the voltage difference between the system and battery is the  $V_{DS}$  of BATFET.

When the battery charging is disabled or terminated, the system is always regulated at 150 mV above the minimum system voltage setting. The status register REG08[0] goes high when the system is in minimum system voltage regulation.



**Figure 11. V(SYS) vs V(BAT)**

### 9.3.2.2 Dynamic Power Management

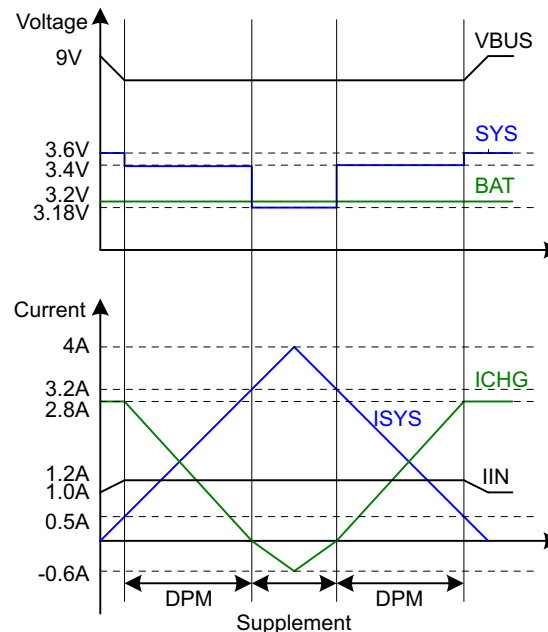
To meet maximum current limit in USB spec and avoid over loading the adapter, the bq24190, bq24192, bq24192I features Dynamic Power Management (DPM), which continuously monitors the input current and input voltage.

When input source is over-loaded, either the current exceeds the input current limit (REG00[2:0]) or the voltage falls below the input voltage limit (REG00[6:3]). The device then reduces the charge current until the input current falls below the input current limit and the input voltage rises above the input voltage limit.

When the charge current is reduced to zero, but the input source is still overloaded, the system voltage starts to drop. Once the system voltage falls below the battery voltage, the device automatically enters the supplement mode where the BATFET turns on and battery starts discharging so that the system is supported from both the input source and battery.

During DPM mode (either VINDPM or IINDPM), the status register REG08[3] will go high.

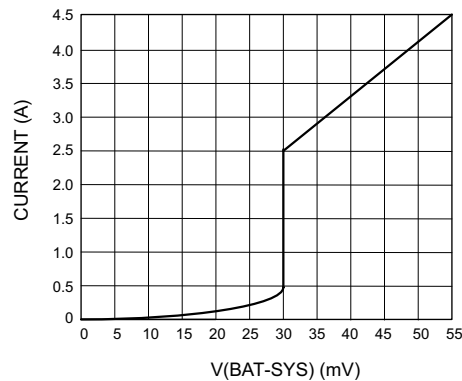
Figure 12 shows the DPM response with 9-V/1.2-A adapter, 3.2-V battery, 2.8-A charge current and 3.4-V minimum system voltage setting.



**Figure 12. DPM Response**

### 9.3.2.3 Supplement Mode

When the system voltage falls below the battery voltage, the BATFET turns on and the BATFET gate is regulated the gate drive of BATFET so that the minimum BATFET  $V_{DS}$  stays at 30 mV when the current is low. This prevents oscillation from entering and exiting the supplement mode. As the discharge current increases, the BATFET gate is regulated with a higher voltage to reduce  $R_{DS(on)}$  until the BATFET is in full conduction. At this point onwards, the BATFET  $V_{DS}$  linearly increases with discharge current. Figure 13 shows the V-I curve of the BATFET gate regulation operation. BATFET turns off to exit supplement mode when the battery is below battery depletion threshold.



**Figure 13. BATFET V-I Curve**

### 9.3.3 Battery Charging Management

The bq24190, bq24192, bq24192I charges 1-cell Li-Ion battery with up to 4.5A charge current for high capacity tablet battery. The 12-mΩ BATFET improves charging efficiency and minimizes the voltage drop during discharging.

#### 9.3.3.1 Autonomous Charging Cycle

With battery charging enabled at POR (REG01[5:4] = 01), the bq24190, bq24192, bq24192I can complete a charging cycle without host involvement. The device default charging parameters are listed in Table 4.

**Table 4. Charging Parameter Default Setting**

| DEFAULT MODE        | bq24190, bq24192       | bq24192I               |
|---------------------|------------------------|------------------------|
| Charging voltage    | 4.208 V                | 4.112 V                |
| Charging Current    | 2.048 A                | 1.024 A                |
| Pre-charge current  | 256 mA                 | 256 mA                 |
| Termination current | 256 mA                 | 256 mA                 |
| Temperature profile | Hot/Cold               | Hot/Cold               |
| Safety timer        | 8 hours <sup>(1)</sup> | 8 hours <sup>(1)</sup> |

(1) See section [Charging Safety Timer](#) for more information.

A new charge cycle starts when the following conditions are valid:

- Converter starts
- Battery charging is enabled by I<sup>2</sup>C register bit (REG01[5:4]) = 01 and  $\overline{CE}$  is low
- No thermistor fault on TS1 and TS2
- No safety timer fault
- BATFET is not forced to turn off (REG07[5])

The charger device automatically terminates the charging cycle when the charging current is below termination threshold and charge voltage is above recharge threshold. When a full battery voltage is discharged below recharge threshold (REG04[0]), the bq24190, bq24192, bq24192I automatically starts another charging cycle.

The STAT output indicates the charging status of charging (LOW), charging complete or charge disable (HIGH) or charging fault (Blinking). The status register REG08[5:4] indicates the different charging phases: 00-charging disable, 01-precharge, 10-fast charge (constant current) and constant voltage mode, 11-charging done. Once a charging cycle is complete, an INT is asserted to notify the host.

The host can always control the charging operation and optimize the charging parameters by writing to the registers through I<sup>2</sup>C.

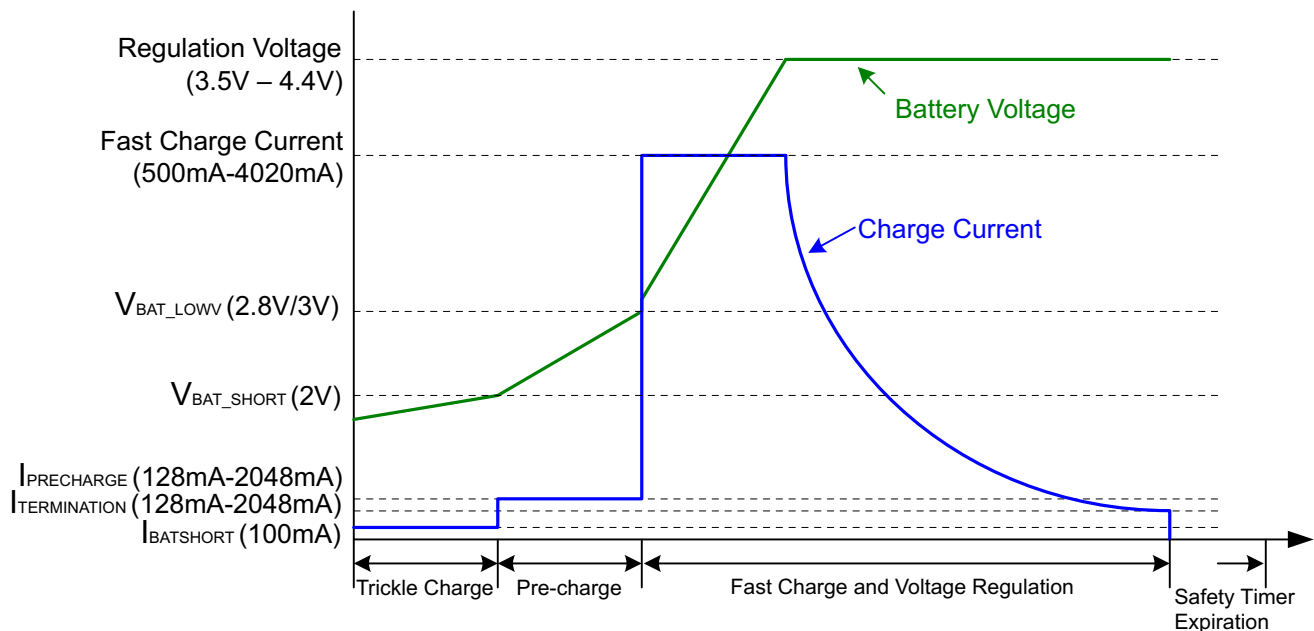
### 9.3.3.2 Battery Charging Profile

The device charges the battery in three phases: preconditioning, constant current and constant voltage. At the beginning of a charging cycle, the device checks the battery voltage and applies current.

**Table 5. Charging Current Setting**

| V <sub>BAT</sub> | CHARGING CURRENT | REG DEFAULT SETTING                      | REG08[5:4] |
|------------------|------------------|------------------------------------------|------------|
| < 2 V            | 100 mA           | –                                        | 01         |
| 2 V - 3 V        | REG03[7:4]       | 256 mA                                   | 01         |
| > 3 V            | REG02[7:2]       | 2048 mA (bq24190/192) 1024 mA (bq24192I) | 10         |

If the charger device is in DPM regulation or thermal regulation during charging, the actual charging current will be less than the programmed value. In this case, termination is temporarily disabled and the charging safety timer is counted at half the clock rate.



**Figure 14. Battery Charging Profile**

### 9.3.3.3 Battery Path Impedance IR Compensation

To speed up the charging cycle, we would like to stay in constant current mode as long as possible. In real system, the parasitic resistance, including routing, connector, MOSFETs and sense resistor in the battery pack, may force the charger device to move from constant current loop to constant voltage loop too early, extending the charge time.

The bq24190, bq24192, bq24192I allows the user to compensate for the parasitic resistance by increasing the voltage regulation set point according to the actual charge current and the resistance. For safe operation, the user should set the maximum allowed regulation voltage to REG06[4:2], and the minimum trace parasitic resistance (REG06[7:5]).

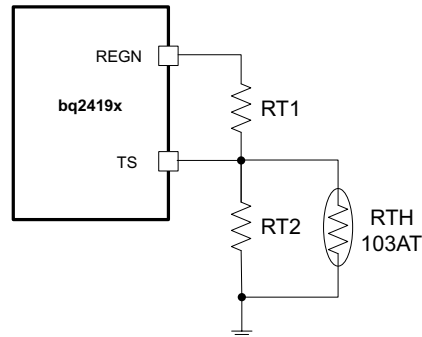
$$V_{\text{BATREG\_ACTUAL}} = V_{\text{BATREG\_I2C}} + \text{lower of } (I_{\text{CHRG\_ACTUAL}} \times R_{\text{COMP}}) \text{ and } V_{\text{CLAMP}} \quad (1)$$

### 9.3.3.4 Thermistor Qualification

The high capacity battery usually has two or more single cells in parallel. The bq24190, bq24192, bq24192I provides two TS pins to monitor the thermistor (NTC) in each cell independently.

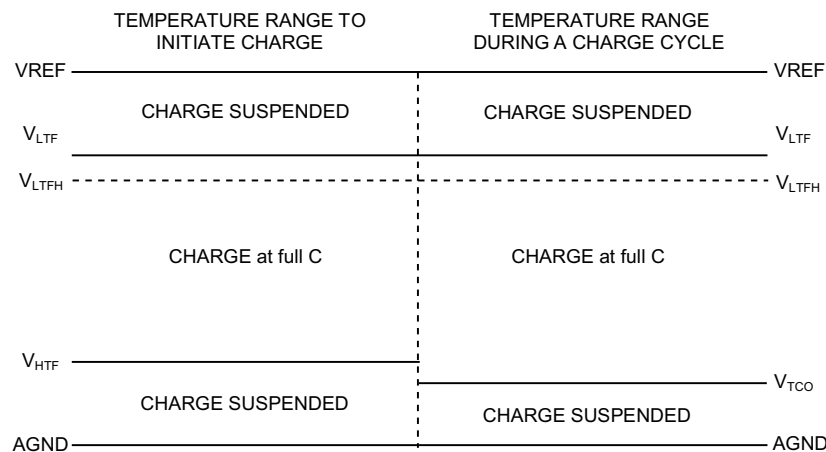
#### 9.3.3.4.1 Cold/Hot Temperature Window

The bq24190, bq24192, bq24192I continuously monitors battery temperature by measuring the voltage between the TS pins and ground, typically determined by a negative temperature coefficient thermistor and an external voltage divider. The device compares this voltage against its internal thresholds to determine if charging is allowed. To initiate a charge cycle, the battery temperature must be within the  $V_{LTF}$  to  $V_{HTF}$  thresholds. During the charge cycle the battery temperature must be within the  $V_{LTF}$  to  $V_{TCO}$  thresholds, else the device suspends charging and waits until the battery temperature is within the  $V_{LTF}$  to  $V_{HTF}$  range.



**Figure 15. TS Resistor Network**

When the TS fault occurs, the fault register REG09[2:0] indicates the actual condition on each TS pin and an INT is asserted to the host. The STAT pin indicates the fault when charging is suspended.



**Figure 16. TS Pin Thermistor Sense Thresholds**

Assuming a 103AT NTC thermistor is used on the battery pack, the value RT1 and RT2 can be determined by using the following equations:

$$RT2 = \frac{V_{VREF} \times RTH_{COLD} \times RTH_{HOT} \times \left( \frac{1}{V_{LTF}} - \frac{1}{V_{TCO}} \right)}{RTH_{HOT} \times \left( \frac{V_{VREF}}{V_{TCO}} - 1 \right) - RTH_{COLD} \times \left( \frac{V_{VREF}}{V_{LTF}} - 1 \right)}$$

$$RT1 = \frac{\frac{V_{VREF}}{V_{LTF}} - 1}{\frac{1}{RT2} + \frac{1}{RTH_{COLD}}}$$
(2)

Select 0°C to 45°C range for Li-ion or Li-polymer battery,

$RTH_{COLD} = 27.28 \text{ k}\Omega$

$RTH_{HOT} = 4.911 \text{ k}\Omega$

$RT1 = 5.52 \text{ k}\Omega$

$RT2 = 31.23 \text{ k}\Omega$

### 9.3.3.5 Charging Termination

The bq24190, bq24192, bq24192I terminates a charge cycle when the battery voltage is above recharge threshold, and the current is below termination current. After the charging cycle is complete, the BATFET turns off. The converter keeps running to power the system, and BATFET can turn back on to engage supplement mode.

When termination occurs, the status register REG08[5:4] is 11, and an INT is asserted to the host. Termination is temporarily disabled if the charger device is in input current/voltage regulation or thermal regulation. Termination can be disabled by writing 0 to REG05[7].

#### 9.3.3.5.1 Termination when REG02[0] = 1

When REG02[0] is HIGH to reduce the charging current by 80%, the charging current could be less than the termination current. The charger device termination function should be disabled. When the battery is charged to fully capacity, the host disables charging through  $\overline{CE}$  pin or REG01[5:4].

#### 9.3.3.5.2 Termination when REG05[6] = 1

Usually the STAT bit indicates charging complete when the charging current falls below termination threshold. Write REG05[6] = 1 to enable an early “charge done” indication on STAT pin. The STAT pin goes high when the charge current reduces below 800 mA. The charging cycle is still on-going until the current falls below the termination threshold.

### 9.3.3.6 Charging Safety Timer

The bq24190, bq24192, bq24192I has safety timer to prevent extended charging cycle due to abnormal battery conditions.

In default mode, the device keeps charging the battery with 5-hour fast charging safety timer regardless of REG05[2:1] default value. At the end of the 5 hours, the EN\_HIZ (REG00[7]) is set to signal the buck converter stops and the system load is supplied by the battery. The EN\_HIZ bit can be cleared to restart the buck converter.

In host mode, the device keeps charging the battery until the fast charging safety timer expired. The duration of safety timer can be set by the REG05[2:1] bits (default = 8 hours). At the end of safety timer, the EN\_HIZ (REG00[7]) is cleared to signal the buck converter continues to operation to supply system load.

The safety timer is 1 hour when the battery is below BATLOWV threshold. The user can program fast charge safety timer through I<sup>2</sup>C (REG05[2:1]). When safety timer expires, the fault register REG09[5:4] goes 11 and an INT is asserted to the host. The safety timer feature can be disabled via I2C (REG05[3]).

The following actions restart the safety timer:

- At the beginning of a new charging cycle

- Toggle the  $\overline{CE}$  pin HIGH to LOW to HIGH (charge enable)
- Write REG01[5:4] from 00 to 01 (charge enable)
- Write REG05[3] from 0 to 1 (safety timer enable)

During input voltage/current regulation or thermal regulation, or when FORCE\_20PCT (REG02[0]) bit is set, the safety timer counts at half clock rate since the actual charge current is likely to be below the register setting. For example, if the charger is in input current regulation (IINDPM) throughout the whole charging cycle, and the safety time is set to 5 hours, the safety timer will expire in 10 hours. This feature can be disabled by writing 0 to REG07[6].

It is recommended to disable safety timer first by clearing REG05[3] bit before safety timer configuration is changed. The safety timer should be re-enabled by setting REG05[3] bit.

### 9.3.3.7 USB Timer when Charging from USB100mA Source

The total charging time in default mode from USB100-mA source is limited by a 45-min max timer. At the end of the timer, the device stops the converter and goes to HIZ.

## 9.3.4 Status Outputs ( $\overline{PG}$ , STAT, and INT)

### 9.3.4.1 Power Good Indicator ( $\overline{PG}$ )

In bq24192, bq24192I,  $\overline{PG}$  goes LOW to indicate a good input source when:

1. VBUS above UVLO
2. VBUS above battery (not in sleep)
3. VBUS below ACOV threshold
4. VBUS above 3.8 V when 30-mA current is applied (not a poor source)

### 9.3.4.2 Charging Status Indicator (STAT)

The bq24190, bq24192, bq24192I indicates charging state on the open drain STAT pin. The STAT pin can drive LED as the application diagram shows.

**Table 6. STAT Pin State**

| CHARGING STATE                                                                           | STAT                                                                        |
|------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------|
| Charging in progress (including recharge)                                                | LOW                                                                         |
| Charging complete                                                                        | HIGH                                                                        |
| Sleep mode, charge disable                                                               | HIGH                                                                        |
| Charge suspend (Input over-voltage, TS fault, timer fault, input or system over-voltage) | blinking at 1Hz (bq24190, bq24192)<br>or 10-k $\Omega$ pull down (bq24192I) |

When a fault occurs, instead of blinking, the STAT pin in bq24192I has a 10-k $\Omega$  pull-down resistor to ground. When the pull-up resistor is 30 k $\Omega$ , the STAT voltage during fault is 1/4 of the pull-up rail.

### 9.3.4.3 Interrupt to Host (INT)

In some applications, the host does not always monitor the charger operation. The INT notifies the system on the device operation. The following events will generate 256-us INT pulse.

- USB/adaptor source identified (through PSEL or DPDM detection, with OTG pin)
- Good input source detected
  - $V_{VBUS} - V_{BAT} > V_{SLEEPZ}$
  - $V_{VBUS} > V_{ACOV}$
  - current limit above  $I_{BADSRC}$
- Input removed
- Charge Complete
- Any FAULT event in REG09

When a fault occurs, the charger device sends out INT and keeps the fault state in REG09 until the host reads the fault register. Before the host reads REG09 and all the faults are cleared, the charger device would not send any INT upon new faults. In order to read the current fault status, the host has to read REG09 two times consecutively. The 1<sup>st</sup> reads fault register status from the last read and the 2<sup>nd</sup> reads the current fault register status.

### 9.3.5 Protections

#### 9.3.5.1 Input Current Limit on ILIM

For safe operation, the bq24190, bq24192, bq24192I has an additional hardware pin on ILIM to limit maximum input current on ILIM pin. The input maximum current is set by a resistor from ILIM pin to ground as:

$$I_{INMAX} = \frac{1V}{R_{ILIM}} \times 530 \quad (3)$$

The actual input current limit is the lower value between ILIM setting and register setting (REG00[2:0]). For example, if the register setting is 111 for 3 A, and ILIM has a 353-Ω resistor to ground for 1.5 A, the input current limit is 1.5 A. ILIM pin can be used to set the input current limit rather than the register settings.

The device regulates ILIM pin at 1 V. If ILIM voltage exceeds 1 V, the device enters input current regulation (Refer to *Dynamic Power Path Management* section).

The voltage on the ILIM pin is proportional to the input current. The ILIM pin can be used to monitor the input current per [Equation 4](#):

$$I_{IN} = \frac{V_{ILIM}}{1V} \times I_{INMAX} \quad (4)$$

For example, if the ILIM pin sets 2 A, and the ILIM voltage is 0.6 V, the actual input current is 1.2 A. If the ILIM pin is open, the input current is limited to zero since ILIM voltage floats above 1 V. If the ILIM pin is short, the input current limit is set by the register.

#### 9.3.5.2 Thermal Regulation and Thermal Shutdown

The bq24190, bq24192, bq24192I monitors the internal junction temperature  $T_J$  to avoid overheat the chip and limits the IC surface temperature. When the internal junction temperature exceeds the preset limit (REG06[1:0]), the device lowers down the charge current. The wide thermal regulation range from 60°C to 120°C allows the user to optimize the system thermal performance.

During thermal regulation, the actual charging current is usually below the programmed battery charging current. Therefore, termination is disabled, the safety timer runs at half the clock rate, and the status register REG08[1] goes high.

Additionally, the device has thermal shutdown to turn off the converter. The fault register REG09[5:4] is 10 and an INT is asserted to the host.

#### 9.3.5.3 Voltage and Current Monitoring in Buck Mode

The bq24190, bq24192, bq24192I closely monitor the input and system voltage, as well as HSFET and LSFET current for safe buck mode operation.

##### 9.3.5.3.1 Input Over-Voltage (ACOV)

The maximum input voltage for buck mode operation is 18 V. If VBUS voltage exceeds 18 V, the device stops switching immediately. During input over voltage (ACOV), the fault register REG09[5:4] will be set to 01. An INT is asserted to the host.

##### 9.3.5.3.2 System Over-Voltage Protection (YSOVP)

The charger device monitors the voltage at SYS. When system over-voltage is detected, the converter is stopped to protect components connected to SYS from high voltage damage.

### **9.3.5.4 Voltage and Current Monitoring in Boost Mode**

The bq24190, bq24192, bq24192I closely monitors the VBUS voltage, as well as HSFET and LSFET current to ensure safe boost mode operation.

#### **9.3.5.4.1 VBUS Over-Voltage Protection**

The boost mode regulated output is 5 V. When an adapter plugs in during boost mode, the VBUS voltage will rise above regulation target. Once the VBUS voltage exceeds 5.3 V, the bq24190, bq24192, bq24192I stops switching and the device exits boost mode. The fault register REG09[6] is set high to indicate fault in boost operation. An INT is asserted to the host.

### **9.3.5.5 Battery Protection**

#### **9.3.5.5.1 Battery Over-Current Protection (BATOVP)**

The battery over-voltage limit is clamped at 4% above the battery regulation voltage. When battery over voltage occurs, the charger device immediately disables charge. The fault register REG09[5] goes high and an INT is asserted to the host.

#### **9.3.5.5.2 Charging During Battery Short Protection**

If the battery voltage falls below 2 V, the charge current is reduced to 100 mA for battery safety.

#### **9.3.5.5.3 System Over-Current Protection**

If the system is shorted or exceeds the over-current limit, the BATFET is latched off. DC source insertion on VBUS is required to reset the latch-off condition and turn on BATFET.

### **9.3.6 Serial Interface**

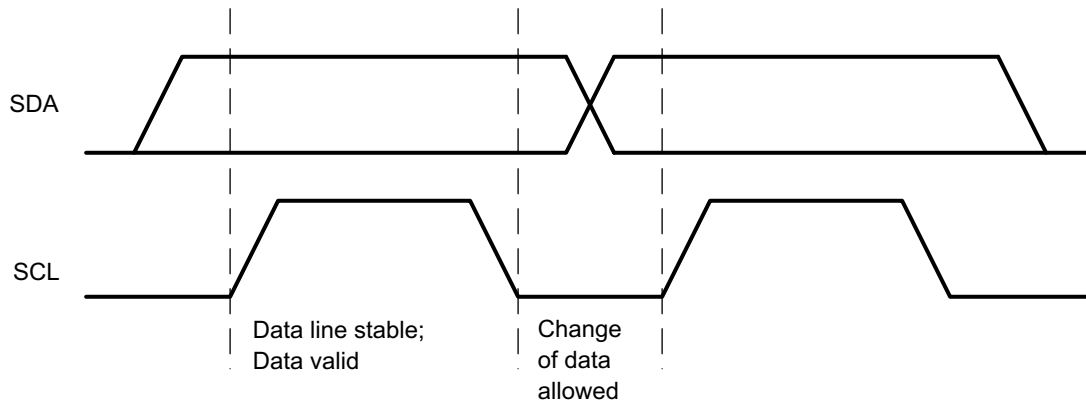
The bq24190, bq24192, bq24192I uses I<sup>2</sup>C compatible interface for flexible charging parameter programming and instantaneous device status reporting. I<sup>2</sup>C is a bi-directional 2-wire serial interface developed by Philips Semiconductor (now NXP Semiconductors). Only two bus lines are required: a serial data line (SDA) and a serial clock line (SCL). Devices can be considered as masters or slaves when performing data transfers. A master is the device which initiates a data transfer on the bus and generates the clock signals to permit that transfer. At that time, any device addressed is considered a slave.

The device operates as a slave device with address 6BH, receiving control inputs from the master device like micro controller or a digital signal processor. The I<sup>2</sup>C interface supports both standard mode (up to 100 kbits), and fast mode (up to 400 kbits).

Both SDA and SCL are bi-directional lines, connecting to the positive supply voltage via a current source or pull-up resistor. When the bus is free, both lines are HIGH. The SDA and SCL pins are open drain.

#### **9.3.6.1 Data Validity**

The data on the SDA line must be stable during the HIGH period of the clock. The HIGH or LOW state of the data line can only change when the clock signal on the SCL line is LOW. One clock pulse is generated for each data bit transferred.

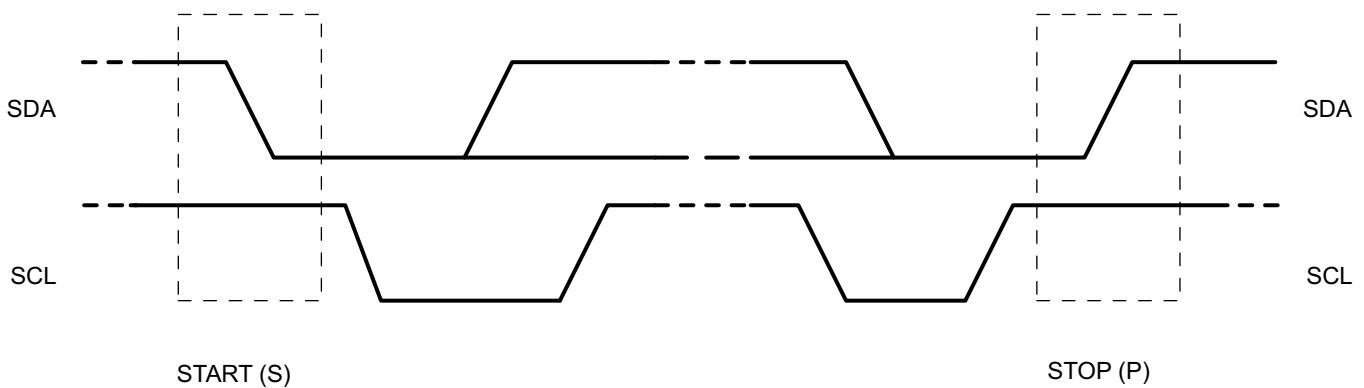


**Figure 17. Bit Transfer on the I²C Bus**

### 9.3.6.2 START and STOP Conditions

All transactions begin with a START (S) and can be terminated by a STOP (P). A HIGH to LOW transition on the SDA line while SCL is HIGH defines a START condition. A LOW to HIGH transition on the SDA line when the SCL is HIGH defines a STOP condition.

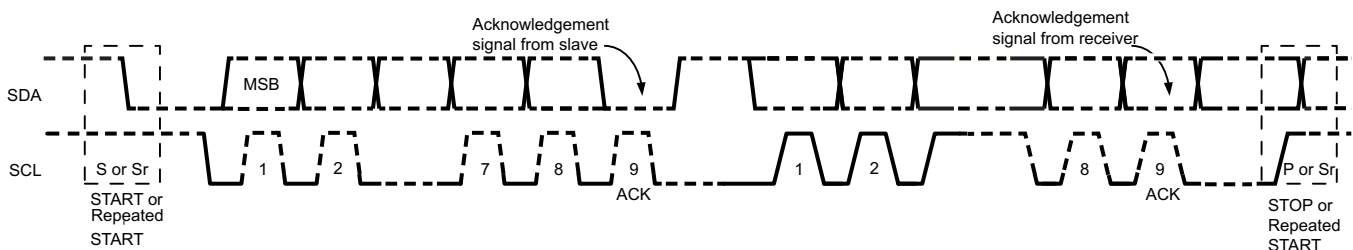
START and STOP conditions are always generated by the master. The bus is considered busy after the START condition, and free after the STOP condition.



**Figure 18. START and STOP conditions**

### 9.3.6.3 Byte Format

Every byte on the SDA line must be 8 bits long. The number of bytes to be transmitted per transfer is unrestricted. Each byte has to be followed by an Acknowledge bit. Data is transferred with the Most Significant Bit (MSB) first. If a slave cannot receive or transmit another complete byte of data until it has performed some other function, it can hold the clock line SCL low to force the master into a wait state (clock stretching). Data transfer then continues when the slave is ready for another byte of data and release the clock line SCL.



**Figure 19. Data Transfer on the I²C Bus**

### 9.3.6.4 Acknowledge (ACK) and Not Acknowledge (NACK)

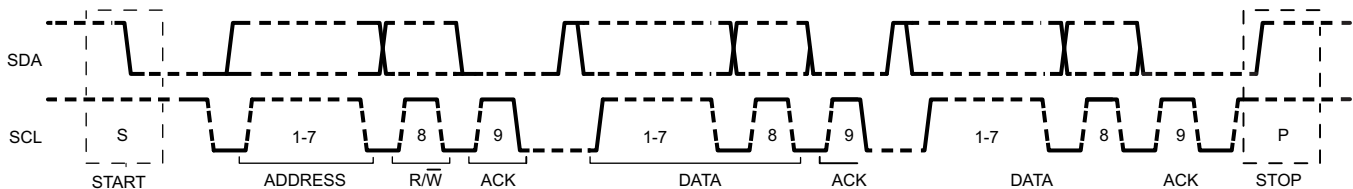
The acknowledge takes place after every byte. The acknowledge bit allows the receiver to signal the transmitter that the byte was successfully received and another byte may be sent. All clock pulses, including the acknowledge 9<sup>th</sup> clock pulse, are generated by the master.

The transmitter releases the SDA line during the acknowledge clock pulse so the receiver can pull the SDA line LOW and it remains stable LOW during the HIGH period of this clock pulse.

When SDA remains HIGH during the 9th clock pulse, this is the Not Acknowledge signal. The master can then generate either a STOP to abort the transfer or a repeated START to start a new transfer.

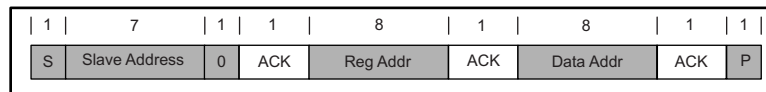
### 9.3.6.5 Slave Address and Data Direction Bit

After the START, a slave address is sent. This address is 7 bits long followed by the eighth bit as a data direction bit (bit R/W). A zero indicates a transmission (WRITE) and a one indicates a request for data (READ).

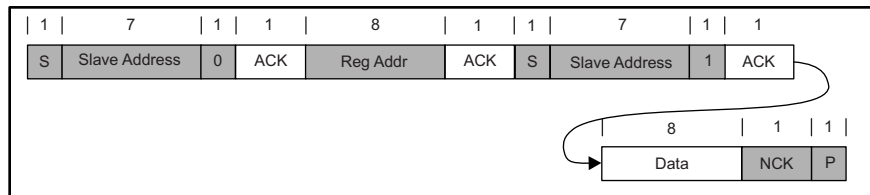


**Figure 20. Complete Data Transfer**

#### 9.3.6.5.1 Single Read and Write



**Figure 21. Single Write**

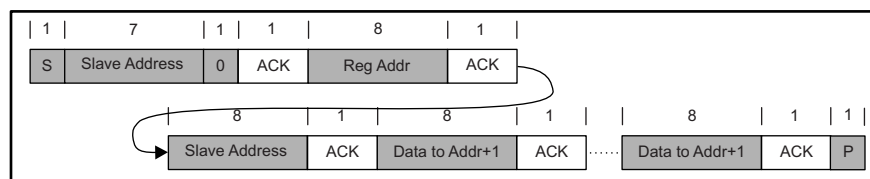


**Figure 22. Single Read**

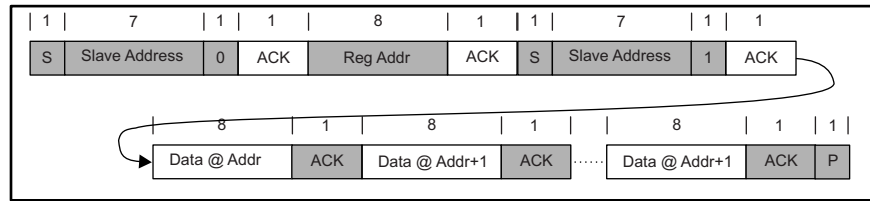
If the register address is not defined, the charger IC send back NACK and go back to the idle state.

#### 9.3.6.5.2 Multi-Read and Multi-Write

The charger device supports multi-read and multi-write on REG00 through REG08.



**Figure 23. Multi-Write**



**Figure 24. Multi-Read**

The fault register REG09 locks the previous fault and only clears it after the register is read. For example, if Charge Safety Timer Expiration fault occurs but recovers later, the fault register REG09 reports the fault when it is read the first time, but returns to normal when it is read the second time. To verify real time fault, the fault register REG09 should be read twice to get the real condition. In addition, the fault register REG09 does not support multi-read or multi-write.

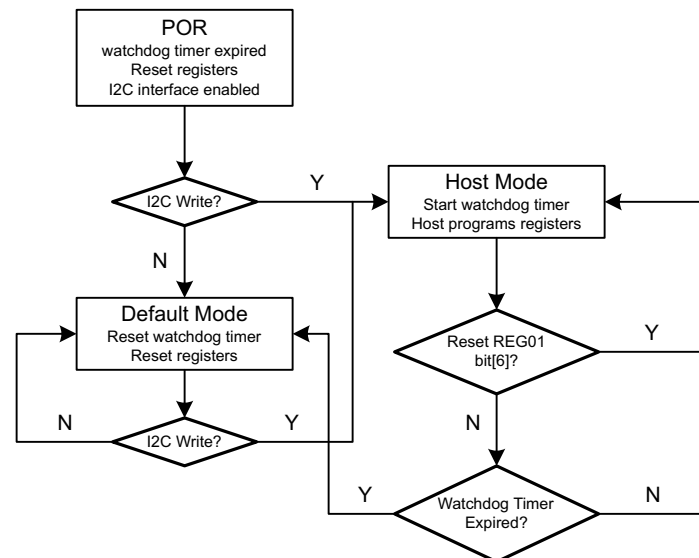
## 9.4 Device Functional Modes

### 9.4.1 Host Mode and Default Mode

The bq24190, bq24192, bq24192I is a host controlled device, but it can operate in default mode without host management. In default mode, bq24190, bq24192, bq24192I can be used as an autonomous charger with no host or with host in sleep.

When the charger is in default mode, REG09[7] is HIGH. When the charger is in host mode, REG09[7] is LOW. After power-on-reset, the device starts in watchdog timer expiration state, or default mode. All the registers are in the default settings.

Any write command to bq24190, bq24192, bq24192I transitions the device from default mode to host mode. All the device parameters can be programmed by the host. To keep the device in host mode, the host has to reset the watchdog timer by writing 1 twice to REG01[6] before the watchdog timer expires (REG05[5:4]), or disable watchdog timer by setting REG05[5:4] = 00.



**Figure 25. Watchdog Timer Flow Chart**

#### 9.4.1.1 Plug in USB100mA Source with Good Battery

When the input source is detected as 100-mA USB host, and the battery voltage is above batgood threshold ( $V_{BATGD}$ ), the charger device enters HIZ state to meet the battery charging spec requirement.

## Device Functional Modes (continued)

If the charger device is in host mode, it will stay in HIZ state even after the USB100-mA source is removed, and the adapter plugs in. During the HIZ state, REG00[7] is set HIGH and the system load is supplied from battery. It is recommended that the processor host always checks if the charger IC is in HIZ state when it wakes up. The host can write REG00[7] to 0 to exit HIZ state.

If the charger is in default mode, when the DC source is removed, the charger device will get out of HIZ state automatically. When the input source plugs in again, the charger IC runs detection on the input source and update the input current limit.

### 9.4.1.2 USB Timer when Charging from USB 100-mA Source

The total charging time in default mode from USB 100-mA source is limited by a 45-min max timer. At the end of the timer, the device stops the converter and goes to HIZ.

## 9.5 Register Map

**Table 7. Register Map**

| REGISTER | REGISTER NAME                                         | RESET                                                          |
|----------|-------------------------------------------------------|----------------------------------------------------------------|
| REG00    | Input Source Control Register                         | bq24190, bq24192: 00110000, or 30<br>bq24192I: 00111000, or 38 |
| REG01    | Power-On Configuration Register                       | 00011011, or 1B                                                |
| REG02    | Charge Current Control Register                       | bq24190, bq24192: 01100000, or 60<br>bq24192I: 00100000, or 20 |
| REG03    | Pre-Charge/Termination Current Control Register       | 00010001, or 11                                                |
| REG04    | Charge Voltage Control Register                       | bq24190, bq24192: 10110010, or B2<br>bq24192I: 10011010, or 9A |
| REG05    | Charge Termination/Timer Control Register             | 10011010, or 9A                                                |
| REG06    | IR Compensation / Thermal Regulation Control Register | 00000011, or 03                                                |
| REG07    | Misc Operation Control Register                       | 01001011, or 4B                                                |
| REG08    | System Status Register                                | —                                                              |
| REG09    | Fault Register                                        | —                                                              |
| REG0A    | Vender / Part / Revision Status Register              | —                                                              |

## 9.5.1 I<sup>2</sup>C Registers

Address: 6BH. REG00-07 support Read and Write. REG08-0A are read only.

### 9.5.1.1 Input Source Control Register REG00 (bq24190, bq24192 reset = 00110000, or 30; bq24192I reset = 00111000, or 38)

**Figure 26. REG00 Input Source Control Register Format**

| 7      | 6         | 5         | 4         | 3         | 2         | 1         | 0         |
|--------|-----------|-----------|-----------|-----------|-----------|-----------|-----------|
| EN_HIZ | VINDPM[3] | VINDPM[2] | VINDPM[1] | VINDPM[0] | IINLIM[2] | IINLIM[1] | IINLIM[0] |
| R/W    | R/W       | R/W       | R/W       | R/W       | R/W       | R/W       | R/W       |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 8. REG00 Input Source Control Register Description**

| BIT                                                                                        | FIELD     | TYPE | RESET                               | DESCRIPTION                                  |                                                                                                                                                        |
|--------------------------------------------------------------------------------------------|-----------|------|-------------------------------------|----------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------|
| Bit 7                                                                                      | EN_HIZ    | R/W  | 0                                   | 0 – Disable, 1 – Enable                      | Default: Disable (0)                                                                                                                                   |
| Input Voltage Limit                                                                        |           |      |                                     |                                              |                                                                                                                                                        |
| Bit 6                                                                                      | VINDPM[3] | R/W  | 0                                   | 640 mV                                       | Offset 3.88 V, Range: 3.88 V to 5.08 V<br>Default:<br>bq24190/bq24192: 4.36 V (0110)<br>bq24192i: 4.44 V (0111)                                        |
| Bit 5                                                                                      | VINDPM[2] | R/W  | 1                                   | 320 mV                                       |                                                                                                                                                        |
| Bit 4                                                                                      | VINDPM[1] | R/W  | 1                                   | 160 mV                                       |                                                                                                                                                        |
| Bit 3                                                                                      | VINDPM[0] | R/W  | 0:<br>(bq24190/92)<br>1: (bq24192I) | 80 mV                                        |                                                                                                                                                        |
| Input Current Limit (Actual input current limit is the lower of I <sup>2</sup> C and ILIM) |           |      |                                     |                                              |                                                                                                                                                        |
| Bit 2                                                                                      | IINLIM[2] | R/W  | 0                                   | 000 – 100 mA, 001 – 150 mA,<br>010 – 500 mA, | Default SDP: 100 mA (000)(OTG pin = 0) or 500<br>mA (010)<br>(OTG pin = 1)<br>Default DCP/CDP:<br>bq24190/bq24192i: 1.5 A (101),<br>bq24192: 3 A (111) |
| Bit 1                                                                                      | IINLIM[1] | R/W  | 0                                   | 011 – 900 mA, 100 – 1.2 A,<br>101 – 1.5 A,   |                                                                                                                                                        |
| Bit 0                                                                                      | IINLIM[0] | R/W  | 0                                   | 110 – 2 A, 111 – 3 A                         |                                                                                                                                                        |

### 9.5.1.2 Power-On Configuration Register REG01 (reset = 00011011, or 1B)

**Figure 27. REG01 Power-On Configuration Register Format**

| 7              | 6                                        | 5             | 4             | 3          | 2          | 1          | 0         |
|----------------|------------------------------------------|---------------|---------------|------------|------------|------------|-----------|
| Register Reset | I <sup>2</sup> C Watchdog<br>Timer Reset | CHG_CONFIG[1] | CHG_CONFIG[0] | SYS_MIN[2] | SYS_MIN[1] | SYS_MIN[0] | BOOST_LIM |
| R/W            | R/W                                      | R/W           | R/W           | R/W        | R/W        | R/W        | R/W       |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 9. REG01 Power-On Configuration Register Description**

| BIT                          | FIELD                                    | TYPE | RESET | DESCRIPTION                                                 | NOTE                                                                         |
|------------------------------|------------------------------------------|------|-------|-------------------------------------------------------------|------------------------------------------------------------------------------|
| Bit 7                        | Register Reset                           | R/W  | 0     | 0 – Keep current register setting,<br>1 – Reset to default  | Default: Keep current register setting (0)<br>Back to 0 after register reset |
| Bit 6                        | I <sup>2</sup> C Watchdog<br>Timer Reset | R/W  | 0     | 0 – Normal ; 1 – Reset                                      | Default: Normal (0)<br>Back to 0 after timer reset                           |
| Charger Configuration        |                                          |      |       |                                                             |                                                                              |
| Bit 5                        | CHG_CONFIG[1]                            | R/W  | 0     | 00 – Charge Disable, 01 – Charge<br>Battery,<br>10/11 – OTG | Default: Charge Battery (01)                                                 |
| Bit 4                        | CHG_CONFIG[0]                            | R/W  | 1     |                                                             |                                                                              |
| Minimum System Voltage Limit |                                          |      |       |                                                             |                                                                              |
| Bit 3                        | SYS_MIN[2]                               | R/W  | 1     | 0.4 V                                                       | Offset: 3.0 V, Range 3.0 V to 3.7 V<br>Default: 3.5 V (101)                  |
| Bit 2                        | SYS_MIN[1]                               | R/W  | 0     | 0.2 V                                                       |                                                                              |
| Bit 1                        | SYS_MIN[0]                               | R/W  | 1     | 0.1 V                                                       |                                                                              |
| Boost Mode Current Limit     |                                          |      |       |                                                             |                                                                              |
| Bit 0                        | BOOST_LIM                                | R/W  | 1     | 0 – 500 mA, 1 – 1.3 A                                       | Default: 1.3 A (1)                                                           |

### 9.5.1.3 Charge Current Control Register REG02 (bq24190, bq24192 reset = 01100000, or 60; bq24192I reset = 00100000, or 20)

**Figure 28. REG02 Charge Current Control Register Format**

| 7       | 6       | 5       | 4       | 3       | 2       | 1        | 0           |
|---------|---------|---------|---------|---------|---------|----------|-------------|
| ICHG[5] | ICHG[4] | ICHG[3] | ICHG[2] | ICHG[1] | ICHG[0] | Reserved | FORCE_20PCT |
| R/W     | R/W     | R/W     | R/W     | R/W     | R/W     | R/W      | R/W         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 10. REG02 Charge Current Control Register Description**

| BIT                       | FIELD       | TYPE | RESET                            | DESCRIPTION                                                                                                                                                                                                                      | NOTE                                                                                                                     |
|---------------------------|-------------|------|----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|
| Fast Charge Current Limit |             |      |                                  |                                                                                                                                                                                                                                  |                                                                                                                          |
| Bit 7                     | ICHG[5]     | R/W  | 0                                | 2048 mA                                                                                                                                                                                                                          | Offset: 512 mA<br>Range: 512 to 4544 mA<br>Default:<br>bq24190, bq24192: 2048 mA (011000),<br>bq24192I: 1024 mA (001000) |
| Bit 6                     | ICHG[4]     | R/W  | 0: (bq24192I)<br>1: (bq24190/92) | 1024 mA                                                                                                                                                                                                                          |                                                                                                                          |
| Bit 5                     | ICHG[3]     | R/W  | 1                                | 512 mA                                                                                                                                                                                                                           |                                                                                                                          |
| Bit 4                     | ICHG[2]     | R/W  | 0                                | 256 mA                                                                                                                                                                                                                           |                                                                                                                          |
| Bit 3                     | ICHG[1]     | R/W  | 0                                | 128 mA                                                                                                                                                                                                                           |                                                                                                                          |
| Bit 2                     | ICHG[0]     | R/W  | 0                                | 64 mA                                                                                                                                                                                                                            |                                                                                                                          |
| Bit 1                     | Reserved    | R/W  | 0                                | 0 - Reserved                                                                                                                                                                                                                     | Reserved. Must write "0"                                                                                                 |
| Bit 0                     | FORCE_20PCT | R/W  | 0                                | 0 - ICHG as REG02[7:2] (Fast Charge Current Limit) and REG03[7:4] (Pre-Charge Current Limit) programmed<br>1 - ICHG as 20% of REG02[7:2] (Fast Charge Current Limit) and 50% of REG03[7:4] (Pre-Charge Current Limit) programmed | Default: ICHG as REG02[7:2] (Fast Charge Current Limit) and REG03[7:4] (Pre-Charge Current Limit) programmed (0)         |

### 9.5.1.4 Pre-Charge/Termination Current Control Register REG03 (reset = 00010001, or 11)

**Figure 29. REG03 Pre-Charge/Termination Current Control Register Format**

| 7          | 6          | 5          | 4          | 3        | 2        | 1        | 0        |
|------------|------------|------------|------------|----------|----------|----------|----------|
| IPRECHG[3] | IPRECHG[2] | IPRECHG[1] | IPRECHG[0] | ITERM[3] | ITERM[2] | ITERM[1] | ITERM[0] |
| R/W        | R/W        | R/W        | R/W        | R/W      | R/W      | R/W      | R/W      |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 11. REG03 Pre-Charge/Termination Current Control Register Description**

| BIT                       | FIELD      | TYPE | RESET | DESCRIPTION | NOTE                                                                                                                           |
|---------------------------|------------|------|-------|-------------|--------------------------------------------------------------------------------------------------------------------------------|
| Pre-Charge Current Limit  |            |      |       |             |                                                                                                                                |
| Bit 7                     | IPRECHG[3] | R/W  | 0     | 1024 mA     | Offset: 128 mA,<br>Range:<br>bq24190, bq24192: 128 mA to 2048 mA<br>bq24192I: 128 mA to 640 mA(0100)<br>Default: 256 mA (0001) |
| Bit 6                     | IPRECHG[2] | R/W  | 0     | 512 mA      |                                                                                                                                |
| Bit 5                     | IPRECHG[1] | R/W  | 0     | 256 mA      |                                                                                                                                |
| Bit 4                     | IPRECHG[0] | R/W  | 1     | 128 mA      |                                                                                                                                |
| Termination Current Limit |            |      |       |             |                                                                                                                                |
| Bit 3                     | ITERM[3]   | R/W  | 0     | 1024 mA     | Offset: 128 mA<br>Range: 128 mA to 2048 mA<br>Default: 256 mA (0001)                                                           |
| Bit 2                     | ITERM[2]   | R/W  | 0     | 512 mA      |                                                                                                                                |
| Bit 1                     | ITERM[1]   | R/W  | 0     | 256 mA      |                                                                                                                                |
| Bit 0                     | ITERM[0]   | R/W  | 1     | 128 mA      |                                                                                                                                |

**bq24190, bq24192, bq24192I**

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**9.5.1.5 Charge Voltage Control Register REG04 (bq24190, bq24192 reset = 10110010, or B2; bq24192I reset = 10011010, or 9A)**
**Figure 30. REG04 Charge Voltage Control Register Format**

| 7       | 6       | 5       | 4       | 3       | 2       | 1       | 0      |
|---------|---------|---------|---------|---------|---------|---------|--------|
| VREG[5] | VREG[4] | VREG[3] | VREG[2] | VREG[1] | VREG[0] | BATLOWV | VRECHG |
| R/W     | R/W     | R/W     | R/W     | R/W     | R/W     | R/W     | R/W    |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 12. REG04 Charge Voltage Control Register Description**

| BIT                                                           | FIELD   | TYPE | RESET                            | DESCRIPTION            | NOTE                                                                                                                                  |
|---------------------------------------------------------------|---------|------|----------------------------------|------------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| Charge Voltage Limit                                          |         |      |                                  |                        |                                                                                                                                       |
| Bit 7                                                         | VREG[5] | R/W  | 1                                | 512 mV                 | Offset: 3.504 V<br>Range: 3.504 V to 4.400 V (111000)<br>Default:<br>bq24190, bq24192: 4.208 V (101100)<br>bq24192I: 4.112 V (100110) |
| Bit 6                                                         | VREG[4] | R/W  | 0                                | 256 mV                 |                                                                                                                                       |
| Bit 5                                                         | VREG[3] | R/W  | 0: (bq24192I)<br>1: (bq24190/92) | 128 mV                 |                                                                                                                                       |
| Bit 4                                                         | VREG[2] | R/W  | 1                                | 64 mV                  |                                                                                                                                       |
| Bit 3                                                         | VREG[1] | R/W  | 0: (bq24190/92)<br>1: (bq24192I) | 32 mV                  |                                                                                                                                       |
| Bit 2                                                         | VREG[0] | R/W  | 0                                | 16 mV                  |                                                                                                                                       |
| Battery Precharge to Fast Charge Threshold                    |         |      |                                  |                        |                                                                                                                                       |
| Bit 1                                                         | BATLOWV | R/W  | 1                                | 0 – 2.8 V, 1 – 3.0 V   | Default: 3.0 V (1)                                                                                                                    |
| Battery Recharge Threshold (below battery regulation voltage) |         |      |                                  |                        |                                                                                                                                       |
| Bit 0                                                         | VRECHG  | R/W  | 0                                | 0 – 100 mV, 1 – 300 mV | Default: 100 mV (0)                                                                                                                   |

**9.5.1.6 Charge Termination/Timer Control Register REG05 (reset = 10011010, or 9A)**
**Figure 31. REG05 Charge Termination/Timer Control Register Format**

| 7       | 6         | 5           | 4           | 3        | 2            | 1            | 0        |
|---------|-----------|-------------|-------------|----------|--------------|--------------|----------|
| EN_TERM | TERM_STAT | WATCHDOG[1] | WATCHDOG[0] | EN_TIMER | CHG_TIMER[1] | CHG_TIMER[0] | Reserved |
| R/W     | R/W       | R/W         | R/W         | R/W      | R/W          | R/W          | R/W      |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 13. REG05 Charge Termination/Timer Control Register Description**

| BIT                             | FIELD        | TYPE | RESET | DESCRIPTION                                                                                            | NOTE                                                             |
|---------------------------------|--------------|------|-------|--------------------------------------------------------------------------------------------------------|------------------------------------------------------------------|
| Charging Termination Enable     |              |      |       |                                                                                                        |                                                                  |
| Bit 7                           | EN_TERM      | R/W  | 1     | 0 – Disable, 1 – Enable                                                                                | Default: Enable termination (1)                                  |
| Termination Indicator Threshold |              |      |       |                                                                                                        |                                                                  |
| Bit 6                           | TERM_STAT    | R/W  | 0     | 0 – Match ITERM,<br>1 – STAT pin high before actual<br>termination when charge current<br>below 800 mA | Default Match ITERM (0)                                          |
| I2C Watchdog Timer Setting      |              |      |       |                                                                                                        |                                                                  |
| Bit 5                           | WATCHDOG[1]  | R/W  | 0     | 00 – Disable timer, 01 – 40 s,<br>10 – 80 s, 11 – 160 s                                                | Default: 40 s (01)                                               |
| Bit 4                           | WATCHDOG[0]  | R/W  | 1     |                                                                                                        |                                                                  |
| Charging Safety Timer Enable    |              |      |       |                                                                                                        |                                                                  |
| Bit 3                           | EN_TIMER     | R/W  | 1     | 0 – Disable, 1 – Enable                                                                                | Default: Enable (1)                                              |
| Fast Charge Timer Setting       |              |      |       |                                                                                                        |                                                                  |
| Bit 2                           | CHG_TIMER[1] | R/W  | 0     | 00 – 5 hrs, 01 – 8 hrs, 10 – 12<br>hrs, 11 – 20 hrs                                                    | Default: 8 hours (01)<br>(See Charging Safety Timer for details) |
| Bit 1                           | CHG_TIMER[0] | R/W  | 1     |                                                                                                        |                                                                  |
| Bit 0                           | Reserved     | R/W  | 0     | 0 - Reserved                                                                                           | Reserved. Must write "0"                                         |

### 9.5.1.7 IR Compensation / Thermal Regulation Control Register REG06 (reset = 00000011, or 03)

**Figure 32. REG06 IR Compensation / Thermal Regulation Control Register Format**

| 7           | 6           | 5           | 4         | 3         | 2         | 1       | 0       |
|-------------|-------------|-------------|-----------|-----------|-----------|---------|---------|
| BAT_COMP[2] | BAT_COMP[1] | BAT_COMP[0] | VCLAMP[2] | VCLAMP[1] | VCLAMP[0] | TREG[1] | TREG[0] |
| R/W         | R/W         | R/W         | R/W       | R/W       | R/W       | R/W     | R/W     |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 14. REG06 IR Compensation / Thermal Regulation Control Register Description**

| BIT                                                      | FIELD       | TYPE | RESET | DESCRIPTION                                  | NOTE                                      |
|----------------------------------------------------------|-------------|------|-------|----------------------------------------------|-------------------------------------------|
| IR Compensation Resistor Setting                         |             |      |       |                                              |                                           |
| Bit 7                                                    | BAT_COMP[2] | R/W  | 0     | 40 mΩ                                        | Range: 0 to 70 mΩ<br>Default: 0 Ω (000)   |
| Bit 6                                                    | BAT_COMP[1] | R/W  | 0     | 20 mΩ                                        |                                           |
| Bit 5                                                    | BAT_COMP[0] | R/W  | 0     | 10 mΩ                                        |                                           |
| IR Compensation Voltage Clamp (above regulation voltage) |             |      |       |                                              |                                           |
| Bit 4                                                    | VCLAMP[2]   | R/W  | 0     | 64 mV                                        | Range: 0 to 112 mV<br>Default: 0 mV (000) |
| Bit 3                                                    | VCLAMP[1]   | R/W  | 0     | 32 mV                                        |                                           |
| Bit 2                                                    | VCLAMP[0]   | R/W  | 0     | 16 mV                                        |                                           |
| Thermal Regulation Threshold                             |             |      |       |                                              |                                           |
| Bit 1                                                    | TREG[1]     | R/W  | 1     | 00 – 60°C, 01 – 80°C, 10 – 100°C, 11 – 120°C | Default: 120°C (11)                       |
| Bit 0                                                    | TREG[0]     | R/W  | 1     |                                              |                                           |

### 9.5.1.8 Misc Operation Control Register REG07 (reset = 01001011, or 4B)

**Figure 33. REG07 Misc Operation Control Register Format**

| 7       | 6        | 5              | 4        | 3        | 2        | 1           | 0           |
|---------|----------|----------------|----------|----------|----------|-------------|-------------|
| DPDM_EN | TMR2X_EN | BATFET_Disable | Reserved | Reserved | Reserved | INT_MASK[1] | INT_MASK[0] |
| R/W     | R/W      | R/W            | R/W      | R/W      | R/W      | R/W         | R/W         |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 15. REG07 Misc Operation Control Register Description**

| BIT                                                                                                      | FIELD          | TYPE | RESET | DESCRIPTION                                                                                                                                             | NOTE                                                                       |
|----------------------------------------------------------------------------------------------------------|----------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------|
| Force DPDM detection (bq24190) or set default input current limit from PSEL/OTG pins (bq24192, bq24192I) |                |      |       |                                                                                                                                                         |                                                                            |
| Bit 7                                                                                                    | DPDM_EN        | R/W  | 0     | 0 – Not in D+/D– detection;<br>1 – Force D+/D– detection                                                                                                | Default: Not in D+/D– detection (0),<br>Back to 0 after detection complete |
| Safety Timer Setting during Input DPM and Thermal Regulation                                             |                |      |       |                                                                                                                                                         |                                                                            |
| Bit 6                                                                                                    | TMR2X_EN       | R/W  | 1     | 0 – Safety timer not slowed by 2X during<br>input DPM or thermal regulation,<br>1 – Safety timer slowed by 2X during<br>input DPM or thermal regulation | Default: Safety timer slowed by 2X (1)                                     |
| Force BATFET Off                                                                                         |                |      |       |                                                                                                                                                         |                                                                            |
| Bit 5                                                                                                    | BATFET_Disable | R/W  | 0     | 0 – Allow Q4 turn on, 1 – Turn off Q4                                                                                                                   | Default: Allow Q4 turn on(0)                                               |
| Bit 4                                                                                                    | Reserved       | R/W  | 0     | 0 – Reserved                                                                                                                                            |                                                                            |
| Bit 4                                                                                                    | Reserved       | R/W  | 0     | 0 – Reserved. Must write "0"                                                                                                                            |                                                                            |
| Bit 3                                                                                                    | Reserved       | R/W  | 1     | 1 – Reserved. Must write "1"                                                                                                                            |                                                                            |
| Bit 2                                                                                                    | Reserved       | R/W  | 0     | 0 – Reserved. Must write "0"                                                                                                                            |                                                                            |
| Bit 1                                                                                                    | INT_MASK[1]    | R/W  | 1     | 0 – No INT during CHRG_FAULT, 1 –<br>INT on CHRG_FAULT                                                                                                  | Default: INT on CHRG_FAULT (1)                                             |
| Bit 0                                                                                                    | INT_MASK[0]    | R/W  | 1     | 0 – No INT during BAT_FAULT, 1 – INT<br>on BAT_FAULT                                                                                                    | Default: INT on BAT_FAULT (1)                                              |

### 9.5.1.9 System Status Register REG08

**Figure 34. REG08 System Status Register Format**

| 7            | 6            | 5            | 4            | 3        | 2       | 1          | 0         |
|--------------|--------------|--------------|--------------|----------|---------|------------|-----------|
| VBUS_STAT[1] | VBUS_STAT[0] | CHRG_STAT[1] | CHRG_STAT[0] | DPM_STAT | PG_STAT | THERM_STAT | VSYS_STAT |
| R            | R            | R            | R            | R        | R       | R          | R         |

LEGEND: R = Read only; -n = value after reset

**Table 16. REG08 System Status Register Description**

| BIT   | FIELD        | TYPE | DESCRIPTION                                                                                             |
|-------|--------------|------|---------------------------------------------------------------------------------------------------------|
| Bit 7 | VBUS_STAT[1] | R    | 00 – Unknown (no input, or DPDM detection incomplete), 01 – USB host, 10 – Adapter port, 11 – OTG       |
| Bit 6 | VBUS_STAT[0] | R    |                                                                                                         |
| Bit 5 | CHRG_STAT[1] | R    | 00 – Not Charging, 01 – Pre-charge ( $<V_{BATLOWV}$ ), 10 – Fast Charging, 11 – Charge Termination Done |
| Bit 4 | CHRG_STAT[0] | R    |                                                                                                         |
| Bit 3 | DPM_STAT     | R    | 0 – Not DPM, 1 – VINDPM or IINDPM                                                                       |
| Bit 2 | PG_STAT      | R    | 0 – Not Power Good, 1 – Power Good                                                                      |
| Bit 1 | THERM_STAT   | R    | 0 – Normal, 1 – In Thermal Regulation                                                                   |
| Bit 0 | VSYS_STAT    | R    | 0 – Not in VSYSMIN regulation ( $BAT > VSYSMIN$ ), 1 – In VSYSMIN regulation ( $BAT < VSYSMIN$ )        |

### 9.5.1.10 Fault Register REG09

**Figure 35. REG09 Fault Register Format**

| 7              | 6           | 5             | 4             | 3         | 2            | 1            | 0            |
|----------------|-------------|---------------|---------------|-----------|--------------|--------------|--------------|
| WATCHDOG_FAULT | BOOST_FAULT | CHRG_FAULT[1] | CHRG_FAULT[0] | BAT_FAULT | NTC_FAULT[2] | NTC_FAULT[1] | NTC_FAULT[0] |
| R              | R           | R             | R             | R         | R            | R            | R            |

LEGEND: R = Read only; -n = value after reset

**Table 17. REG09 Fault Register Description**

| BIT   | FIELD          | TYPE | DESCRIPTION                                                                                                                           |
|-------|----------------|------|---------------------------------------------------------------------------------------------------------------------------------------|
| Bit 7 | WATCHDOG_FAULT | R    | 0 – Normal, 1- Watchdog timer expiration                                                                                              |
| Bit 6 | BOOST_FAULT    | R    | 0 – Normal, 1 – VBUS overloaded (OCP), or VBUS OVP in boost mode                                                                      |
| Bit 5 | CHRG_FAULT[1]  | R    | 00 – Normal, 01 – Input fault (VBUS OVP or $VBAT < VBUS < 3.8\text{ V}$ ), 10 - Thermal shutdown, 11 – Charge Safety Timer Expiration |
| Bit 4 | CHRG_FAULT[0]  | R    |                                                                                                                                       |
| Bit 3 | BAT_FAULT      | R    | 0 – Normal, 1 – BATOVP                                                                                                                |
| Bit 2 | NTC_FAULT[2]   | R    | 000 – Normal, 001 – TS1 Cold, 010 – TS1 Hot, 011 – TS2 Cold, 100 – TS2 Hot, 101 – Both Cold, 110 – Both Hot                           |
| Bit 1 | NTC_FAULT[1]   | R    |                                                                                                                                       |
| Bit 0 | NTC_FAULT[0]   | R    |                                                                                                                                       |

**9.5.1.11 Vender / Part / Revision Status Register REG0A (bq24190 reset = 00100011, or 23; bq24192 reset = 00101011, or 2B; bq24192I reset = 00001011, or 0B)**

**Figure 36. REG0A Vender / Part / Revision Status Register Format**

| 7        | 6        | 5     | 4     | 3     | 2          | 1          | 0          |
|----------|----------|-------|-------|-------|------------|------------|------------|
| Reserved | Reserved | PN[2] | PN[1] | PN[0] | TS_PROFILE | DEV_REG[0] | DEV_REG[1] |
| R        | R        | R     | R     | R     | R          | R          | R          |

LEGEND: R = Read only; -n = value after reset

**Table 18. REG0A Vender / Part / Revision Status Register Description**

| BIT                  | FIELD      | TYPE | RESET                            | DESCRIPTION                                  |
|----------------------|------------|------|----------------------------------|----------------------------------------------|
| Bit 7                | Reserved   | R    | 0                                | 0 - Reserved                                 |
| Bit 6                | Reserved   | R    | 0                                | 0 - Reserved                                 |
| Device Configuration |            |      |                                  |                                              |
| Bit 5                | PN[2]      | R    | 0: (bq24192I)<br>1: (bq24190/92) | bq24190 – 100, bq24192 – 101, bq24192I – 011 |
| Bit 4                | PN[1]      | R    | 0                                |                                              |
| Bit 3                | PN[0]      | R    | 0: (bq24190)<br>1: (bq24192/92I) |                                              |
| Bit 2                | TS_PROFILE | R    | 0                                | 0 – Cold/Hot window                          |
| Bit 1                | DEV_REG[0] | R    | 1                                | 11                                           |
| Bit 0                | DEV_REG[1] | R    | 1                                |                                              |

## 10 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

A typical application consists of the device configured as an I<sup>2</sup>C controlled power path management device and a single cell Li-Ion battery charger for single cell Li-Ion and Li-polymer batteries used in a wide range of tablets and other portable devices. It integrates an input reverse-blocking FET (RBFET, Q1), high-side switching FET (HSFET, Q2), low-side switching FET (LSFET, Q3), and BATFET (Q4) between the system and battery. The device also integrates a bootstrap diode for the high-side gate drive.

### 10.2 Typical Application

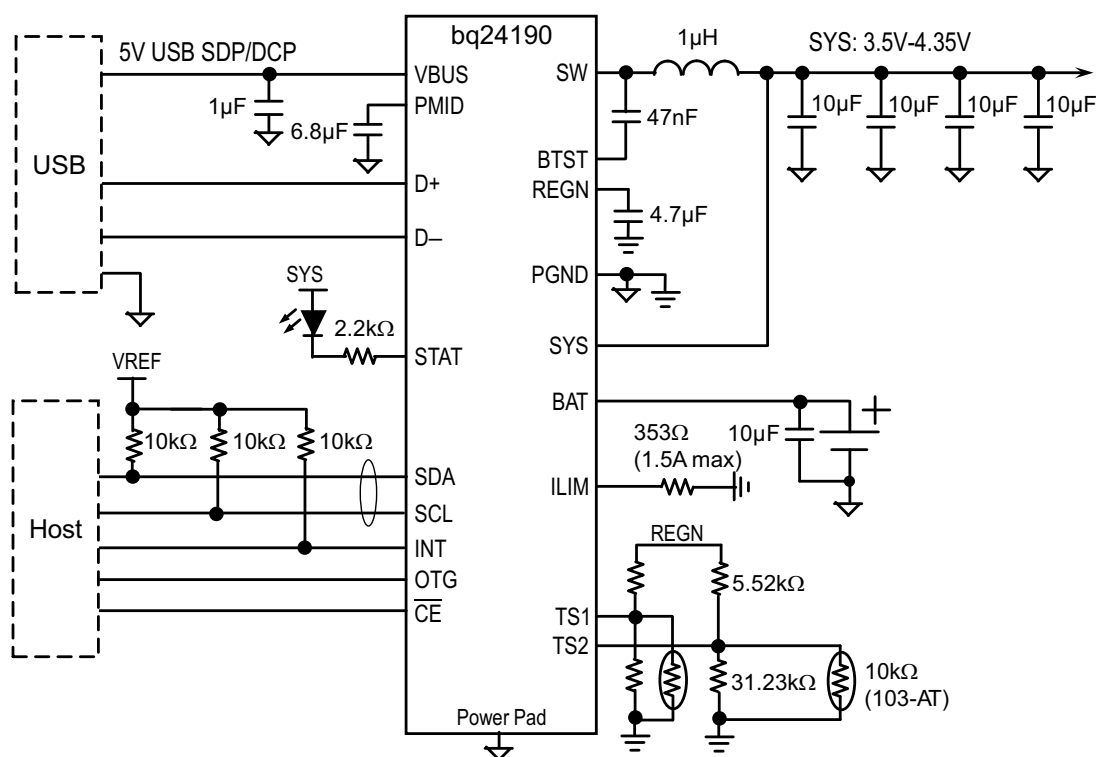
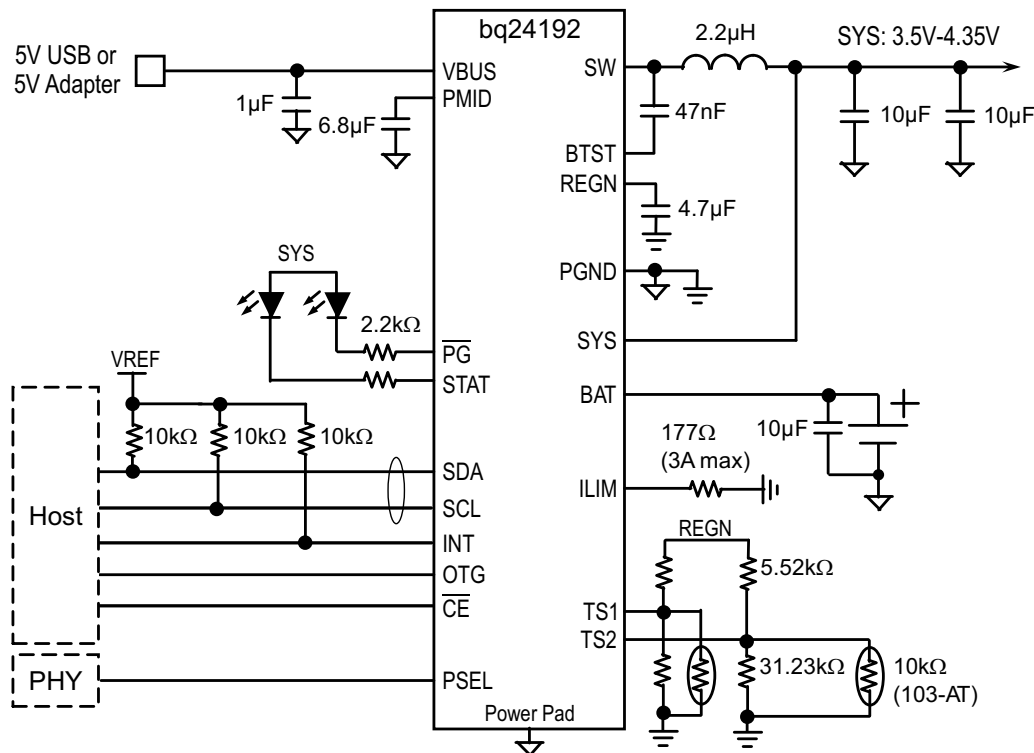
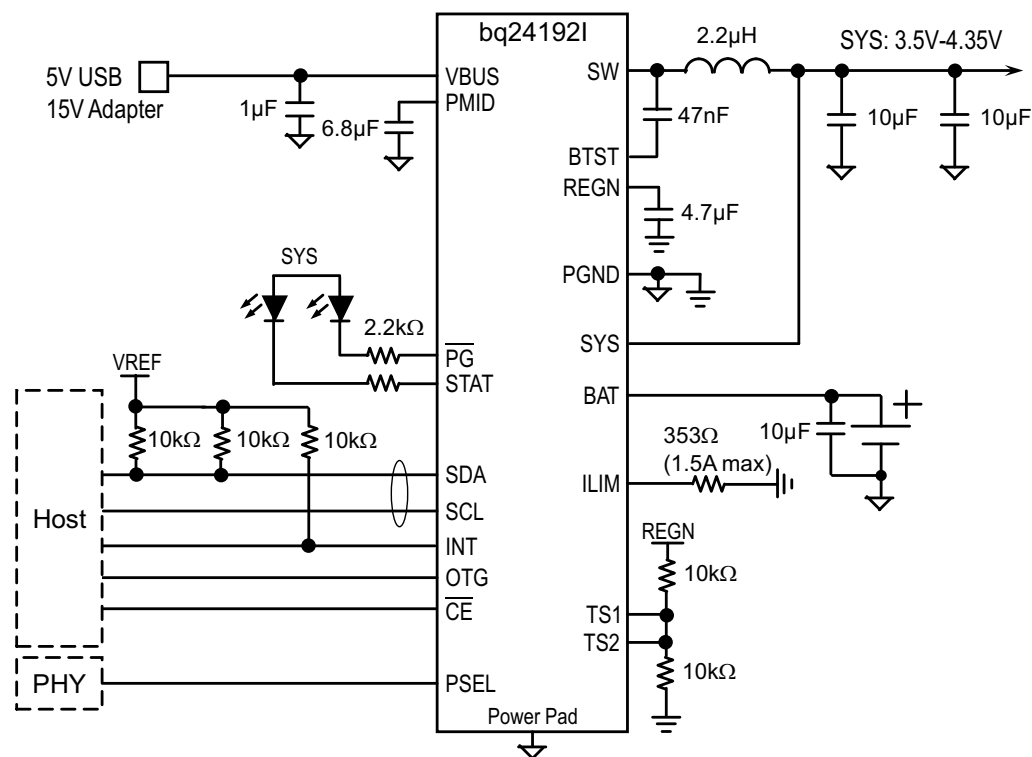


Figure 37. bq24190 with D+/D- Detection and USB On-The-Go (OTG)

## Typical Application (continued)



**Figure 38. bq24192 with PSEL and USB On-The-Go (OTG)**



**Figure 39. bq24192I with PSEL, USB On-The-Go (OTG), No Thermistor Connections**

## Typical Application (continued)

### 10.2.1 Design Requirements

**Table 19. Design Requirements**

| DESIGN PARAMETER          | EXAMPLE VALUE |
|---------------------------|---------------|
| Input voltage             | 3.9 V to 17 V |
| Input current limit       | 3000 mA       |
| Fast charge current       | 4000 mA       |
| Boost mode output current | 1.3 A         |

### 10.2.2 Detailed Design Procedure

#### 10.2.2.1 Inductor Selection

The bq24190, bq24192, bq24192I has 1.5-MHz switching frequency to allow the use of small inductor and capacitor values. The inductor saturation current should be higher than the charging current ( $I_{CHG}$ ) plus half the ripple current ( $I_{RIPPLE}$ ):

$$I_{SAT} \geq I_{CHG} + (1/2) I_{RIPPLE} \quad (5)$$

The inductor ripple current depends on input voltage ( $V_{BUS}$ ), duty cycle ( $D = V_{BAT}/V_{BUS}$ ), switching frequency ( $f_s$ ) and inductance ( $L$ ):

$$I_{RIPPLE} = \frac{V_{IN} \times D \times (1-D)}{f_s \times L} \quad (6)$$

The maximum inductor ripple current happens with  $D = 0.5$  or close to 0.5. Usually inductor ripple is designed in the range of (20 to 40%) maximum charging current as a trade-off between inductor size and efficiency for a practical design. Typical inductor value is 2.2  $\mu$ H.

#### 10.2.2.2 Input Capacitor

Input capacitor should have enough ripple current rating to absorb input switching ripple current. The worst case RMS ripple current is half of the charging current when duty cycle is 0.5. If the converter does not operate at 50% duty cycle, then the worst case capacitor RMS current  $I_{CIN}$  occurs where the duty cycle is closest to 50% and can be estimated by the following equation:

$$I_{CIN} = I_{CHG} \times \sqrt{D \times (1-D)} \quad (7)$$

For best performance,  $V_{BUS}$  should be decouple to PGND with 1- $\mu$ F capacitance. The remaining input capacitor should be place on PMID.

Low ESR ceramic capacitor such as X7R or X5R is preferred for input decoupling capacitor and should be placed to the drain of the high side MOSFET and source of the low side MOSFET as close as possible. Voltage rating of the capacitor must be higher than normal input voltage level. 25-V rating or higher capacitor is preferred for 15-V input voltage.

#### 10.2.2.3 Output Capacitor

Output capacitor also should have enough ripple current rating to absorb output switching ripple current. The output capacitor RMS current  $I_{COUT}$  is given:

$$I_{COUT} = \frac{I_{RIPPLE}}{2 \times \sqrt{3}} \approx 0.29 \times I_{RIPPLE} \quad (8)$$

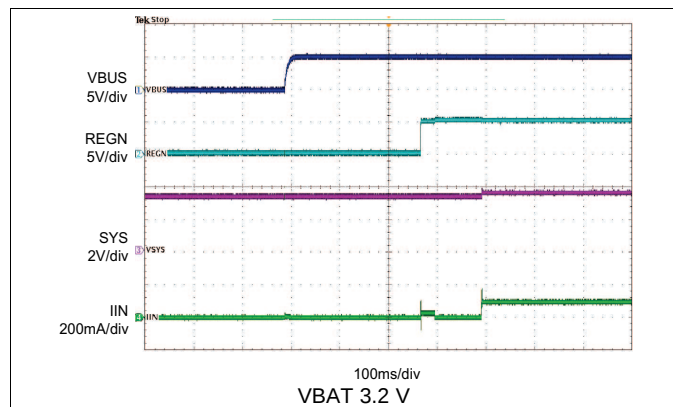
The output capacitor voltage ripple can be calculated as follows:

$$\Delta V_O = \frac{V_{OUT}}{8LCf_s^2} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right) \quad (9)$$

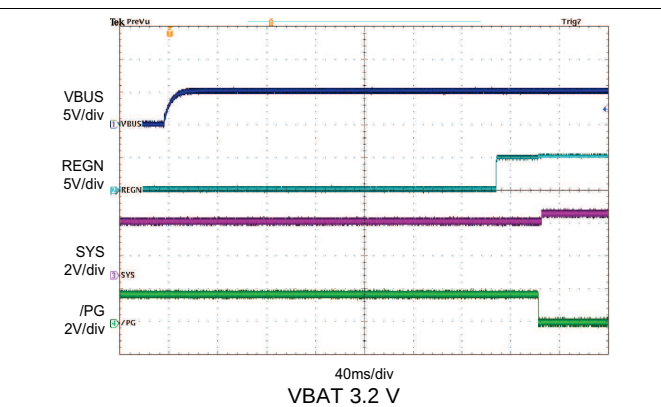
At certain input/output voltage and switching frequency, the voltage ripple can be reduced by increasing the output filter LC.

The charger device has internal loop compensator. To get good loop stability, the resonant frequency of the output inductor and output capacitor should be designed between 15 kHz and 25 kHz. With 2.2- $\mu$ H inductor, the typical output capacitor value is 20  $\mu$ F. The preferred ceramic capacitor is 6 V or higher rating, X7R or X5R.

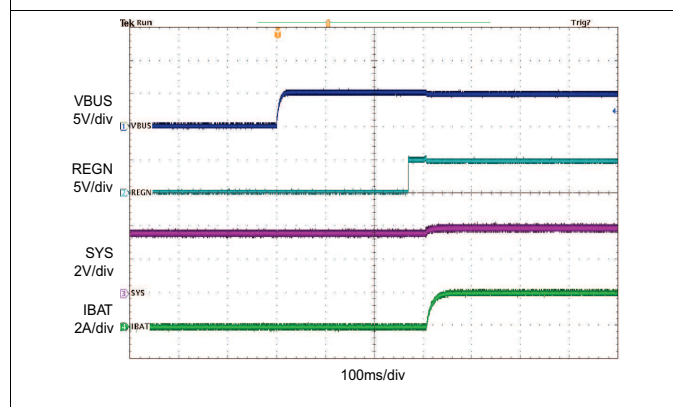
### 10.2.3 Application Performance Plots



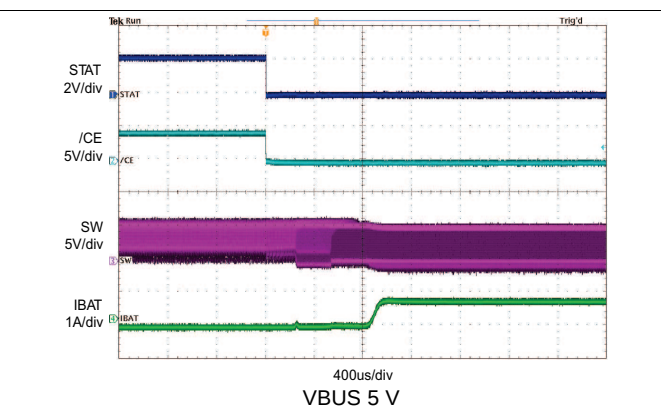
**Figure 40. bq24190 Power Up from USB100 mA**



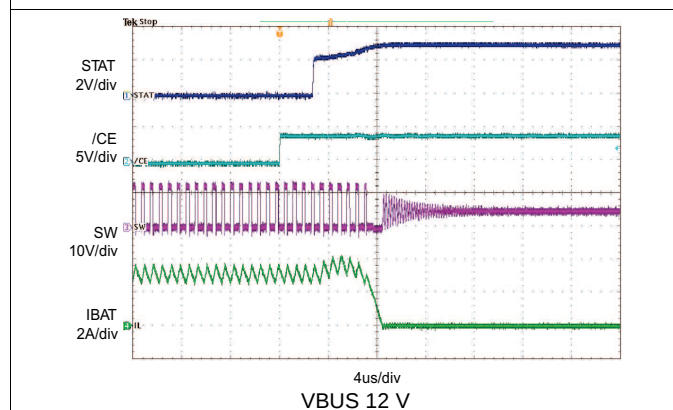
**Figure 41. bq24192 Power Up with Charge Disabled**



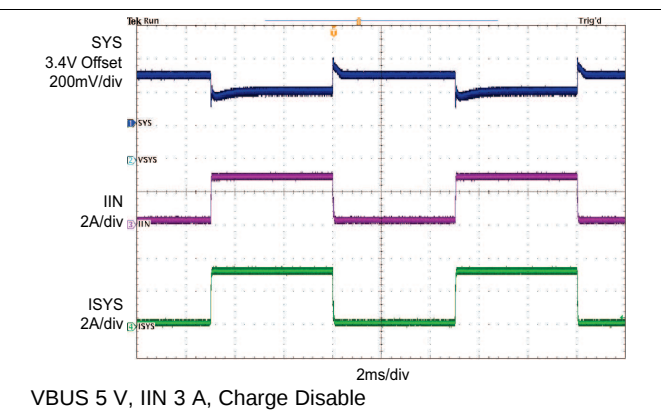
**Figure 42. bq24192 Power Up with Charge Enabled**



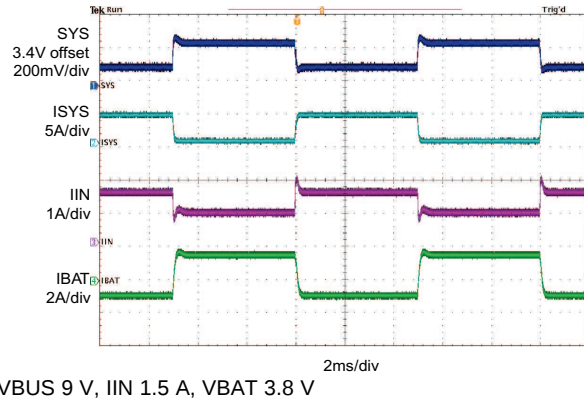
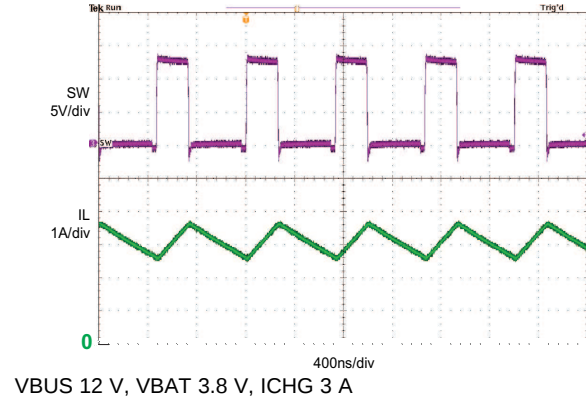
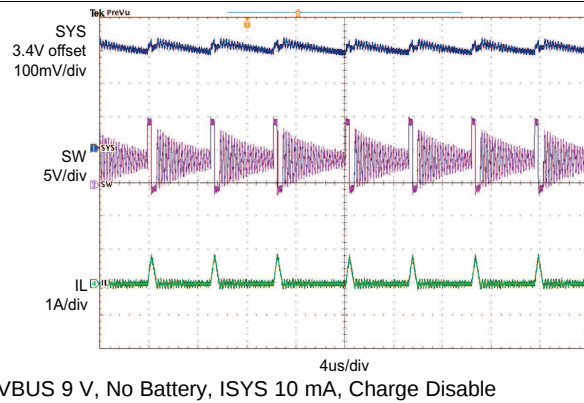
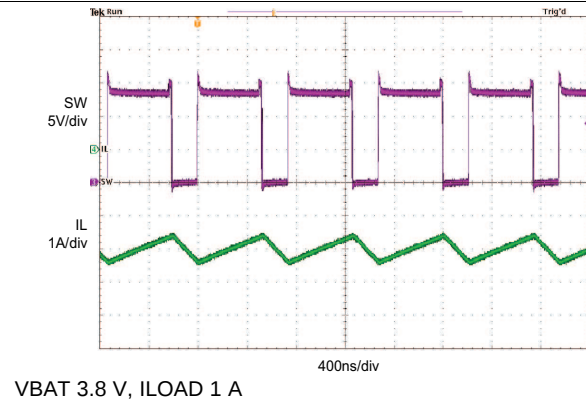
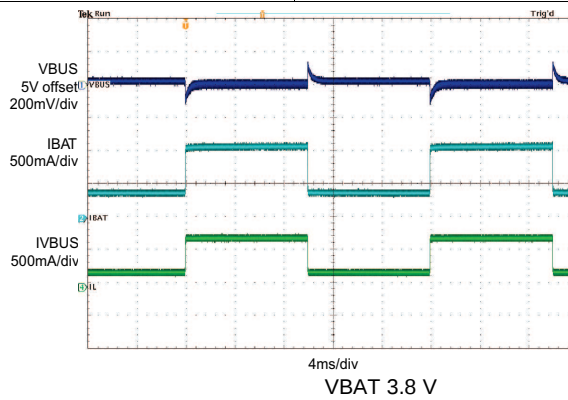
**Figure 43. Charge Enable**



**Figure 44. Charge Disable**



**Figure 45. Input Current DPM Response without Battery**


**Figure 46. Load Transient During Supplement Mode**

**Figure 47. PWM Switching Waveform**

**Figure 48. PFM Switching Waveform**

**Figure 49. Boost Mode Switching Waveform**

**Figure 50. Boost Mode Load Transient**

## 11 Power Supply Recommendations

In order to provide an output voltage on SYS, the bq2419x require a power supply between 3.9 V and 17 V input with at least 100 mA current rating connected to VBUS; or, a single-cell Li-Ion battery with voltage  $> V_{BATUVLO}$  connected to BAT. The source current rating needs to be at least 3 A in order for the buck converter of the charger to provide maximum output power to SYS.

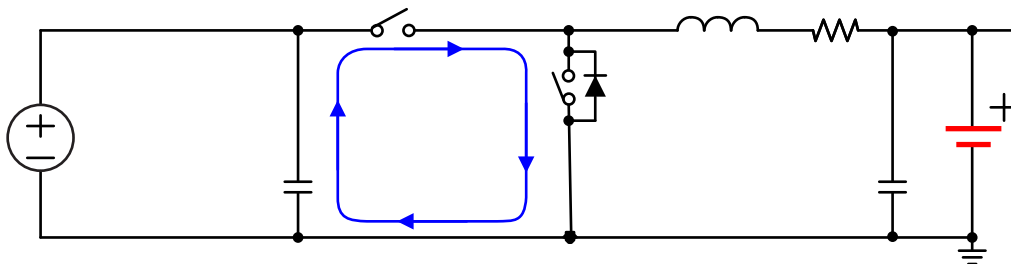
## 12 Layout

### 12.1 Layout Guidelines

The switching node rise and fall times should be minimized for minimum switching loss. Proper layout of the components to minimize high frequency current path loop (see [Figure 51](#)) is important to prevent electrical and magnetic field radiation and high frequency resonant problems. Here is a PCB layout priority list for proper layout. Layout PCB according to this specific order is essential.

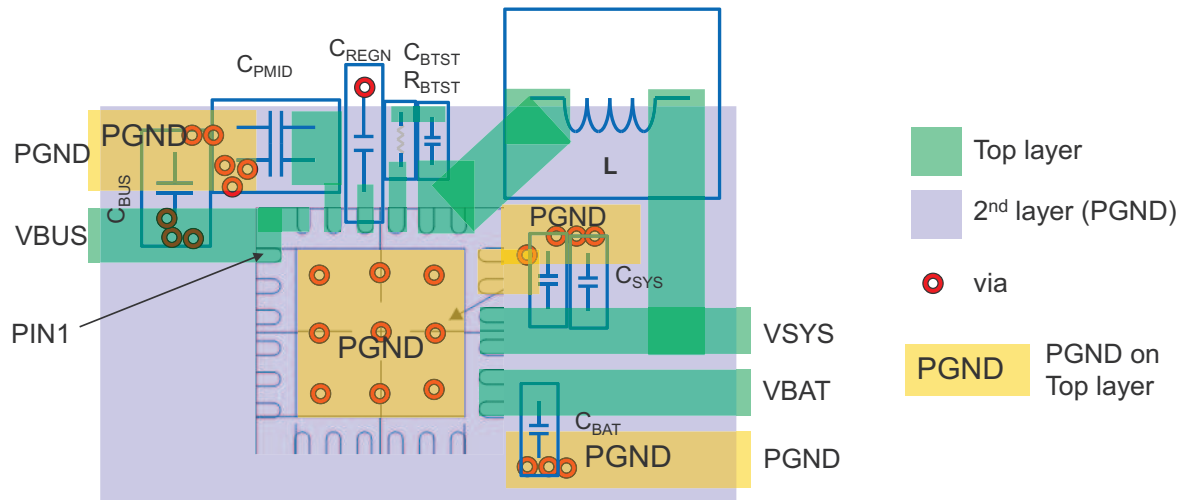
1. Place input capacitor as close as possible to PMID pin and GND pin connections and use shortest copper trace connection or GND plane.
2. Place inductor input terminal to SW pin as close as possible. Minimize the copper area of this trace to lower electrical and magnetic field radiation but make the trace wide enough to carry the charging current. Do not use multiple layers in parallel for this connection. Minimize parasitic capacitance from this area to any other trace or plane.
3. Put output capacitor near to the inductor and the IC. Ground connections need to be tied to the IC ground with a short copper trace connection or GND plane.
4. Route analog ground separately from power ground. Connect analog ground and connect power ground separately. Connect analog ground and power ground together using power pad as the single ground connection point. Or using a 0-Ω resistor to tie analog ground to power ground.
5. Use single ground connection to tie charger power ground to charger analog ground. Just beneath the IC. Use ground copper pour but avoid power pins to reduce inductive and capacitive noise coupling.
6. Decoupling capacitors should be placed next to the IC pins and make trace connection as short as possible.
7. It is critical that the exposed power pad on the backside of the IC package be soldered to the PCB ground. Ensure that there are sufficient thermal vias directly under the IC, connecting to the ground plane on the other layers.
8. The via size and number should be enough for a given current path.

See the EVM design for the recommended component placement with trace and via locations. For the VQFN information, refer to [SCBA017](#) and [SLUA271](#).



**Figure 51. High Frequency Current Path**

## 12.2 Layout Example



**Figure 52. Layout Example Diagram**

## 13 Device and Documentation Support

### 13.1 Documentation Support

#### 13.1.1 Related Documentation

*bq2419x EVM (PWR021) User's Guide* ([SLUUA14](#))

*Quad Flatpack No-Lead Logic Packages Application Report* ([SCBA017](#))

*QFN/SON PCB Attachment Application Report* ([SLUA271](#))

### 13.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 20. Related Links**

| PARTS    | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|----------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| bq24190  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| bq24192  | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| bq24192I | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 13.3 Trademarks

All trademarks are the property of their respective owners.

### 13.4 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 13.5 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## **14 Mechanical, Packaging, and Orderable Information**

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">BQ24190RGER</a>  | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24190             |
| BQ24190RGER.A                | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24190             |
| <a href="#">BQ24190RGET</a>  | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24190             |
| BQ24190RGET.A                | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24190             |
| <a href="#">BQ24192IRGER</a> | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | BQ<br>24192I        |
| BQ24192IRGER.A               | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | BQ<br>24192I        |
| <a href="#">BQ24192IRGET</a> | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ<br>24192I        |
| BQ24192IRGET.A               | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ<br>24192I        |
| <a href="#">BQ24192RGER</a>  | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |
| BQ24192RGER.A                | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |
| BQ24192RGERG4                | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |
| BQ24192RGERG4.A              | Active        | Production           | VQFN (RGE)   24 | 3000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |
| <a href="#">BQ24192RGET</a>  | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |
| BQ24192RGET.A                | Active        | Production           | VQFN (RGE)   24 | 250   SMALL T&R       | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -40 to 85    | BQ24192             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

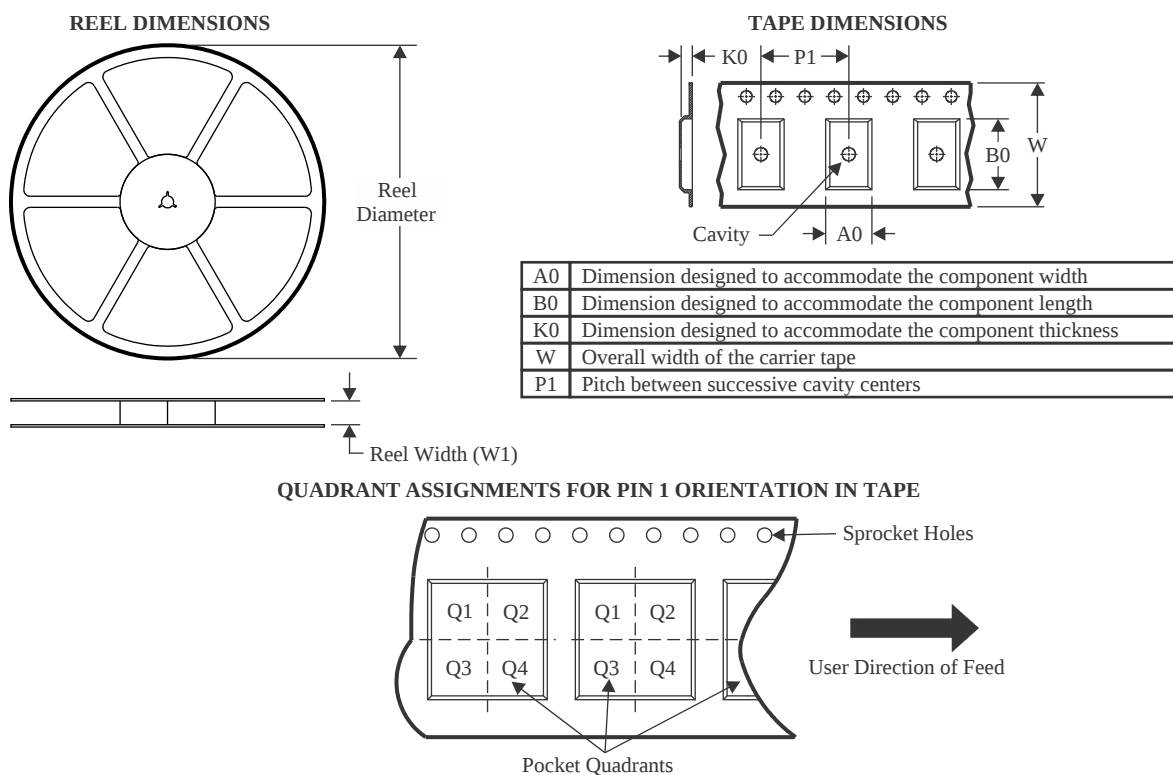
**(6) Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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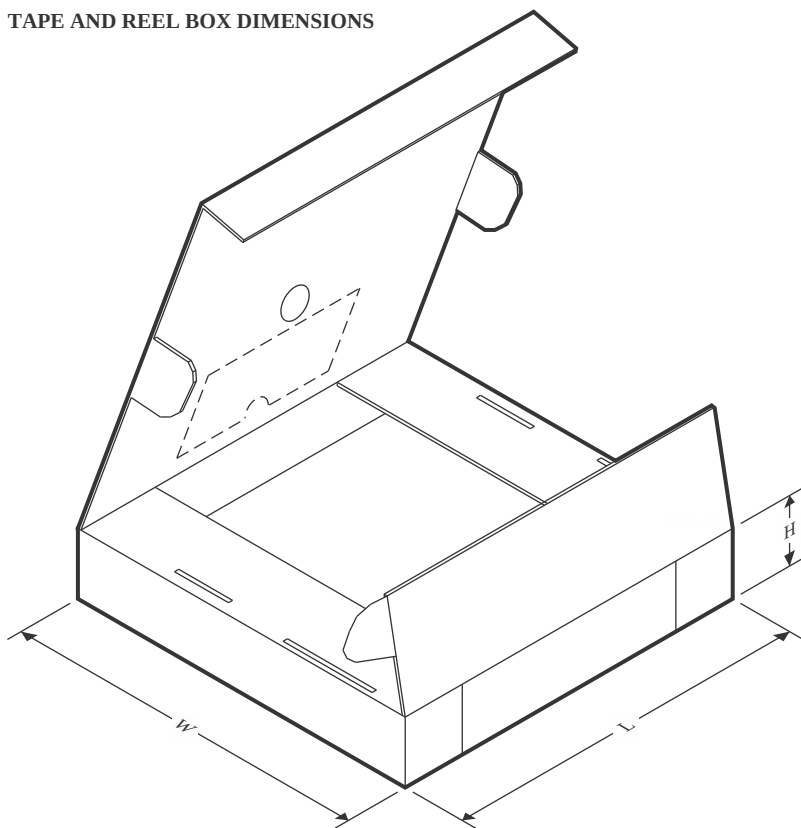
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| BQ24190RGER   | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24190RGET   | VQFN         | RGE             | 24   | 250  | 180.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192IRGER  | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192IRGER  | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192IRGET  | VQFN         | RGE             | 24   | 250  | 180.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192RGER   | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192RGER   | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192RGERG4 | VQFN         | RGE             | 24   | 3000 | 330.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |
| BQ24192RGET   | VQFN         | RGE             | 24   | 250  | 180.0              | 12.4               | 4.25    | 4.25    | 1.15    | 8.0     | 12.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

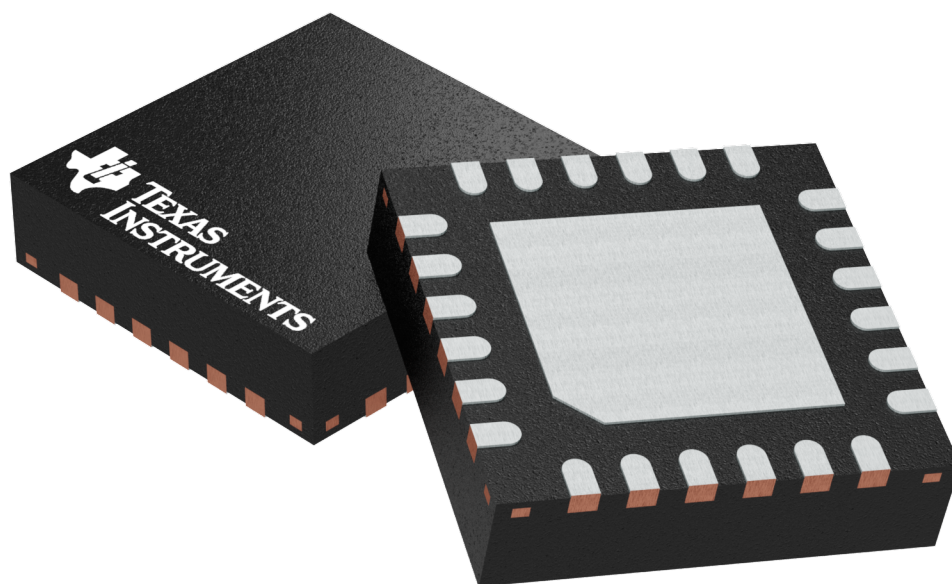
| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| BQ24190RGER   | VQFN         | RGE             | 24   | 3000 | 346.0       | 346.0      | 33.0        |
| BQ24190RGET   | VQFN         | RGE             | 24   | 250  | 210.0       | 185.0      | 35.0        |
| BQ24192IRGER  | VQFN         | RGE             | 24   | 3000 | 346.0       | 346.0      | 33.0        |
| BQ24192IRGER  | VQFN         | RGE             | 24   | 3000 | 360.0       | 360.0      | 36.0        |
| BQ24192IRGET  | VQFN         | RGE             | 24   | 250  | 210.0       | 185.0      | 35.0        |
| BQ24192RGER   | VQFN         | RGE             | 24   | 3000 | 360.0       | 360.0      | 36.0        |
| BQ24192RGER   | VQFN         | RGE             | 24   | 3000 | 346.0       | 346.0      | 33.0        |
| BQ24192RGERG4 | VQFN         | RGE             | 24   | 3000 | 346.0       | 346.0      | 33.0        |
| BQ24192RGET   | VQFN         | RGE             | 24   | 250  | 210.0       | 185.0      | 35.0        |

**RGE 24**

**GENERIC PACKAGE VIEW**

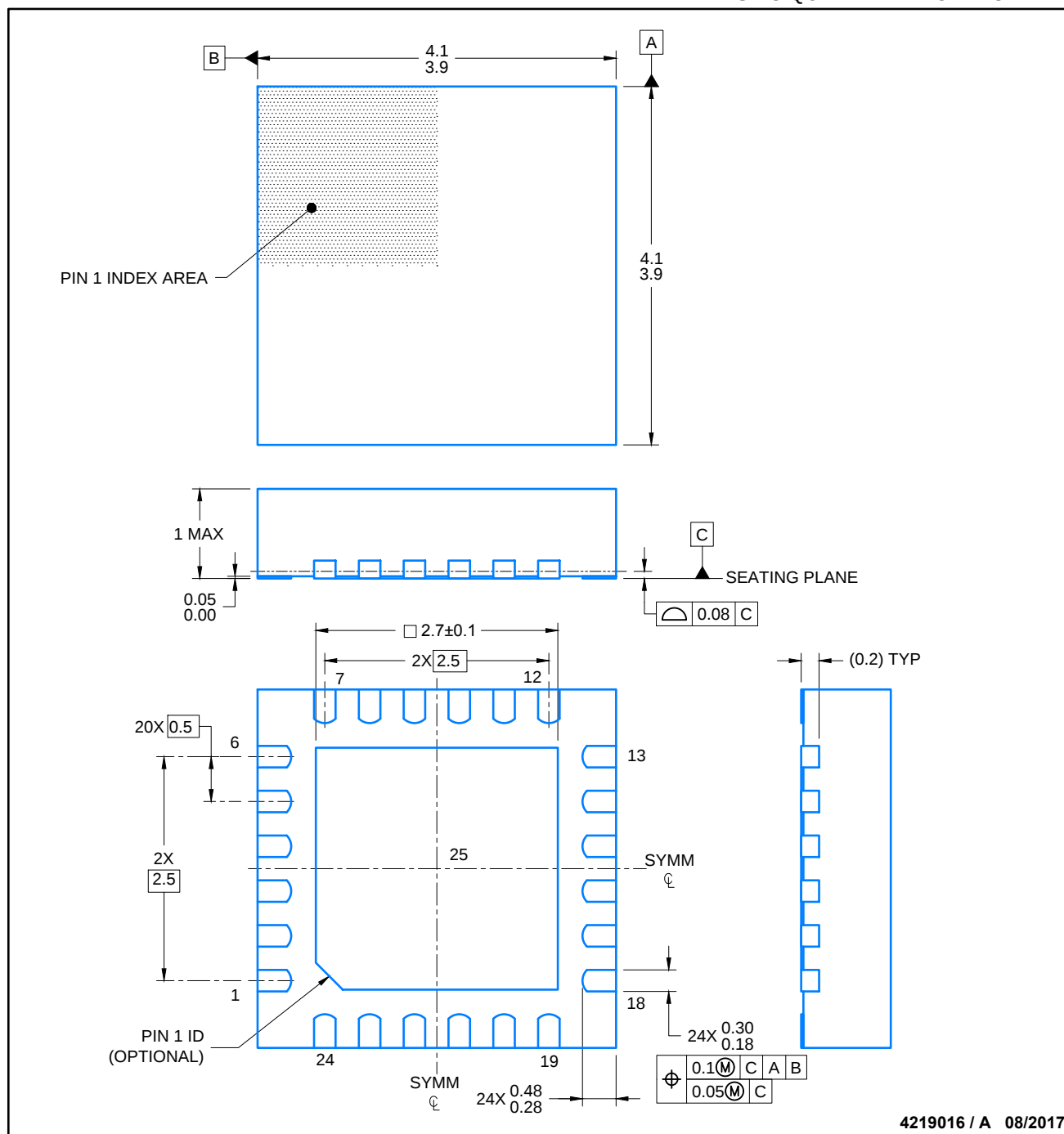
**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

4204104/H



## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

### VQFN - 1 mm max height

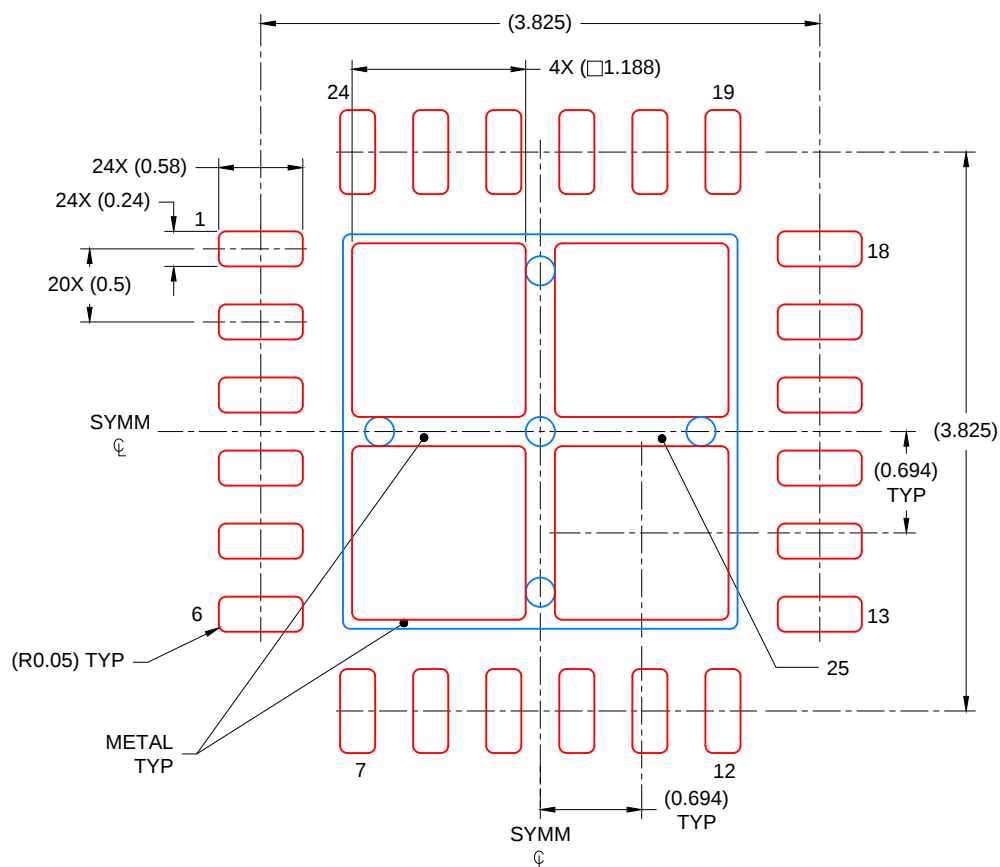
This mechanical drawing shows a 19-pin connector layout. The overall width is 3.825 inches. The pin pitch is 0.2 inches, with a total width of 24X (0.58) inches for the pin array. The pin numbers 1 through 19 are indicated. The drawing includes dimensions for the pin array (24X (0.58), 24X (0.24), 20X (0.5)), the central area (2X (1.1)), and the overall width (3.825). A central square area is defined by 2.7 inches. The drawing also shows a SYMM (Symmetry) line and a (Ø0.2) VIA TYP.

The diagram illustrates two types of solder mask openings on a metal pad:

- NON SOLDER MASK DEFINED (PREFERRED):** This type shows a metal pad with a solder mask opening. The dimension is specified as **0.07 MAX ALL AROUND**, indicating the maximum width of the metal pad surrounding the opening.
- SOLDER MASK DEFINED:** This type shows a metal pad with a solder mask opening. The dimension is specified as **0.07 MIN ALL AROUND**, indicating the minimum width of the metal pad surrounding the opening.

Labels in the diagram include: METAL, SOLDER MASK OPENING, and SOLDER MASK DETAILS.

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
78% PRINTED COVERAGE BY AREA  
SCALE: 20X

4219016 / A 08/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations..

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